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(NASA-CR-171163) SURFACE ANALYSIS OF SPACE  
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SURFACE ANALYSIS OF SPACE TELESCOPE MATERIAL SPECIMENS  
(NAS8-35914)

Monthly Report for July  
(July 31, 1984)

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## Abstract

Surface analysis by electron spectroscopy for chemical analysis (ESCA) was used to characterize a number of the samples during the past month. With ESCA, the sample is irradiated with monoenergetic soft x-rays and the resulting emitted electrons are energy analyzed to determine the binding energy of electrons to the surface atoms. The major peaks were used in the quantitative determination of the surface composition. (Please refer to Tables 1 through 16 which are interspersed with the figures.) The presence of trace elements (impurities below 1% atomic composition) was also detailed. Initially a survey scan was run for each sample to deduce the elemental composition. Then the major peaks of interest and those of the trace elements were individually examined. After this, the samples were argon sputtered to etch away surface layers, and then additional measurements were carried out in order to obtain depth profile information. Those species present only on the surface could in this way be distinguished from those having a significant depth distribution within the sample.

It was estimated on July 31 that the measurements were 90% complete. It is expected that the measurements will be 100% complete by August 30, 1984.

## ESCA Data for Silver and Copper Specimens

### Silver

Four silver samples have thus far been examined: a silver interconnect flown on STS-8, a silver foil flown on STS-8, the relevant control silver specimen for these samples, and a gold-plated silver foil which had been subjected to the plasma asher for a period of two minutes. Several common trends were found for all silver samples:

1. The flight and ashed samples exhibited a slight decrease in binding energy (0.1 to 0.3 eV) of the Ag 3d doublet relative to the control. (These data are given in Figs. 1, 2, 9, 21, and 22.) These results indicate an increase in the degree of oxidation of silver (viz.,  $\text{Ag} \Rightarrow \text{Ag}_2\text{O} \Rightarrow \text{AgO}$ ).
2. Chemical shifts toward oxygen species with lower O(1s) binding energies (B.E.) occurred in the flight and ashed samples. (These data are given in Figs. 5, 6, 11, 12, 17, 18, 23, and 24).
3. The control sample always had a Ag to O ratio of 1:1 at the surface of the sample. (These data are given in Tables 2, 4, 6, and 8. It should be pointed out, however, that this is not necessarily evidence that the chemical composition of the surface is  $\text{AgO}$ , although the data are consistent with this interpretation.)
4. A decrease in carbon was observed in the ashed and flight samples relative to the control. (See Tables 1, 2, 3, 4, 5, 6, 7, and 8.)

The ashing process, surprisingly, did not seem to simulate very well the processes which occurred during exposure to the ambient during flight. The flight samples exhibited shifts toward increased surface concentrations of oxygen at lower binding energies, but new chemical bonding forms were not observed. Figures 17, 18, 23, and 24 indicate only shifts between oxygen species originally present on the surface. On the other hand, the ashed samples exhibited not only this effect, but also the creation of new oxygen species at still lower binding energies (see Figs. 5, 6, 11, and 12).

Ashed and flight samples also differed in the silver to oxygen ratio. Whereas the control showed a 1:1 ratio, the ashed samples showed a decrease and the flight samples showed an increase in this ratio. The results are as follows:

#### Silver-to-Oxygen Ratios

Control Sample:	1.0
Gold-plated Silver after Ashing:	0.2
Silver Foil after Ashing:	0.4
Silver Foil after Flight:	2.5
Silver Interconnect after Flight:	1.5

The gold-plated silver sample deserves special mention due to the unusual effect of the plasma asher treatment. Even the control sample exhibited a silver peak at the surface, which is rather surprising. (It would be expected that the gold plating would have entirely protected the underlying silver.) The ratio of gold to silver was found to be 4 to 1. After ashing, gold was barely detectable (see Figs. 3 and 4). Quantitatively it was found that the gold to silver ratio went from 4 to 1 before ashing to a ratio of 1 to 13 after ashing. Possibly this could have been due to a bulk diffusion of the gold into the silver foil during ashing. It seems unlikely that the gold was sputtered away, since the sample weight measurements by the Marshall personnel indicated no weight loss during ashing. Another possible explanation is that the adhesion of the gold to the silver was affected by plasma ashing, so that the gold aggregated into small beads, thereby leaving the silver surface exposed.

The composition of the silver interconnect and the underlying silver foil after flight were very similar (see Tables 6 and 8). However the control sample for the interconnect was found to have a larger amount of graphitic carbon. It was found that this carbon could be easily removed by sputtering. The flight interconnect had somewhat more carbon than the flight foil. The flight foil also contained sulfur and chlorine, elements not found on the interconnect.

## Copper

Cupric oxide was found on both the control and flight samples (see Fig. 27). The amounts of carbon and oxygen were less in the flight samples, as indicated below.

### Oxygen-to-Copper and Carbon-to-Copper Ratios

	O/Cu	C/Cu
Control Sample:	5.2	5.9
Flight Sample:	1.1	3.8

A shift to lower binding energy oxygen was observed in the flight sample (see Fig. 28). The carbon type, however, was unchanged (see Fig. 29).

## ESCA Data for Paint Specimens

Because the paint samples were non-metallic, some electrical charging occurred during the ESCA study. As a consequence, the positions of the peaks at times appeared as much as 6 eV higher than expected. This was more evident in the A-276 and the 401-C10 specimens than in the Z-302 specimen, the latter being scarcely affected by charging. The degree of surface charging depends not only on the low electrical conductivity of the sample, but also on the thickness of the specimen because this will control the rate of charge leakage to the underlying metal substrate. The consequence is that peak positions were inconsistent from sample to sample, and in addition, the peak positions were observed to change with sputtering of the sample. Therefore the energy axis of the ESCA scans should not be used to infer absolute binding energy, and the shifts in energy should not be used indiscriminantly to infer changes in chemical binding.

In view of the foregoing, it is not surprising that few consistent trends were found by means of ESCA for the paint specimens. Nevertheless, the A-276 and Z-302 samples did show a slight decrease in the silicon-to-oxygen ratio, while the 401-C10 sample exhibited a significant increase. The data supporting these statements are now given.

## Silicon-to-Oxygen Ratios

	A-276	Z-302	401-C10
Control Sample:	0.48	0.29	0.13
Flight Sample:	0.30	0.19	0.88

For the A-276 specimens, the silica, oxygen, and carbon peaks were unaffected by flight, as indicated by comparison of the flight and control sample data (see Figs. 31, 32, and 33). For the Z-302 specimens, the silica peak was broader in the flight sample, and the peak was broadened by sputtering (see Figs. 34 and 35). No change occurred in the N(1s) or O(1s) peaks (see Figs. 36, 37, 40, and 41). Three forms of carbon were present on the Z-302 control. The flight sample exhibited a shift in one of the higher binding energy forms of carbon (see Figs. 38 and 39).

Although the peaks in the 401-C10 flight sample appeared to be shifted towards higher binding energy, this seems to be a consequence of a difference in the degree of charging of the flight and control specimens. Perhaps the thicknesses of the samples were not the same. Assuming this to be the case, there does not appear to be a difference in the oxygen species between the flight and control specimens (see Figs. 42 and 43). Two forms of silicon were present on the control specimen, with the higher binding energy form predominant. The flight sample, on the other hand, showed no lower binding energy form (see Figs. 44 and 45). The carbon peaks indicated a behavior resembling that of the Z-302 samples, namely, the flight sample exhibits a shift to a higher binding form relative to the control sample (see Figs. 46 and 47).



Sample: Gold-plated Silver / Ashed 2 min  
 Treatment:  
 Date: 7-31-84

scan	peak	B.E. (eV)	ch. #	inten.	E <sub>0</sub> (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
AUF1	Ag(3d <sup>3/2</sup> )	373.6		2x10 <sup>3</sup> /1	20							
	Ag(3d <sup>5/2</sup> )	367.6	318			~11,000	405575	4.05x10 <sup>7</sup>	15 Å	10.7	0.14	Ag
AUF4	Au(4f <sup>5/2</sup> )	87.45	245	1x10 <sup>3</sup> /5	200	~11,000						
	Au(4f <sup>7/2</sup> )	83.8	330			~11,000	316000	3.16x10 <sup>7</sup>	16 Å	9.79	0.01	Au
AUF2	O(1s)	522.7	239	2x10 <sup>3</sup> /1	50	~11,000			14 Å	2.85		
		520.7	290			~7500						
		518.7	341			~11,000	447115	1.76x10 <sup>7</sup>			0.64	O
AUF3	C(1s)	288.3	117	1x10 <sup>3</sup> /2	50				15 Å	1.00		
		286.3	198									
		284.3	249				587760	5.88x10 <sup>7</sup>			0.21	C

Comments:

$$\frac{A_u}{A_g} \approx \frac{1}{13}$$

$$\frac{A_g}{O} \approx \frac{1}{5}$$

$$\frac{A_u}{A_g} \approx \frac{1}{13}$$

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Figures:

Table 1

Sample: Gold-plated Silver / Control  
 Treatment:  
 Date: 7-29-84

scan	peak	B.E. (eV)	ch. #	inten.	E <sub>0</sub> (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
AUC 1	Ag 2d <sub>5/2</sub>	373.1		$1 \times 10^3 / 1$	20							
	Ag 2d <sub>3/2</sub>	367.7	314			7,500	256,000	$1.29 \times 10^7$	15 Å	10.7	0.08	Ag
AUC 2	Au 4f <sub>7/2</sub>	87.50	244	$1 \times 10^3 / 1$	50	4,800						
	Au 4f <sub>5/2</sub>	83.85	337			5,700	238,000	$4.76 \times 10^7$	16 Å	9.79	0.30	Au
AUC 3	O 1s	532.7	237	$5 \times 10^3 / 2$	20	5,600			14 Å	2.85		
		530.7	290			1,200						
							254,000	$3.175 \times 10^6$			0.08	O
ATC 4	C 1s	286.0	206	$2 \times 10^3 / 2$	50	1,500			15 Å	1.00		
		284.4	246			5,600		$9.1 \times 10^6$				
							4105,000				0.54	C

Comments:

$Au = \frac{4}{1}$   
 $Ag = \frac{1}{1}$   
 $Ag = \frac{1}{0}$

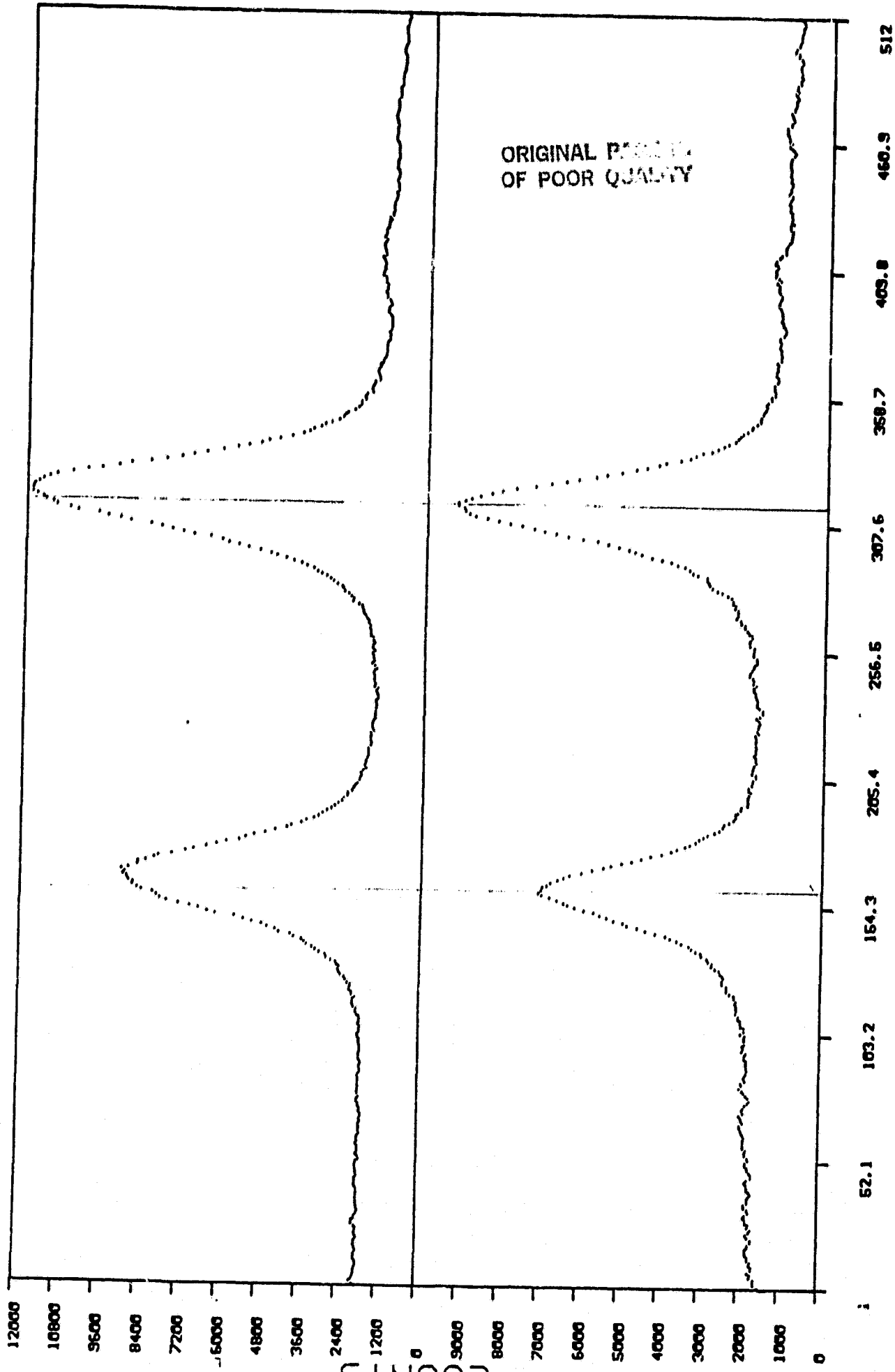
Figures:

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$Au = 3^3$   
 $Ag$

Table 2

# Au-PLATED Ag ASHED/CONTROL - Ag 3d 3/2 and 3d 5/2

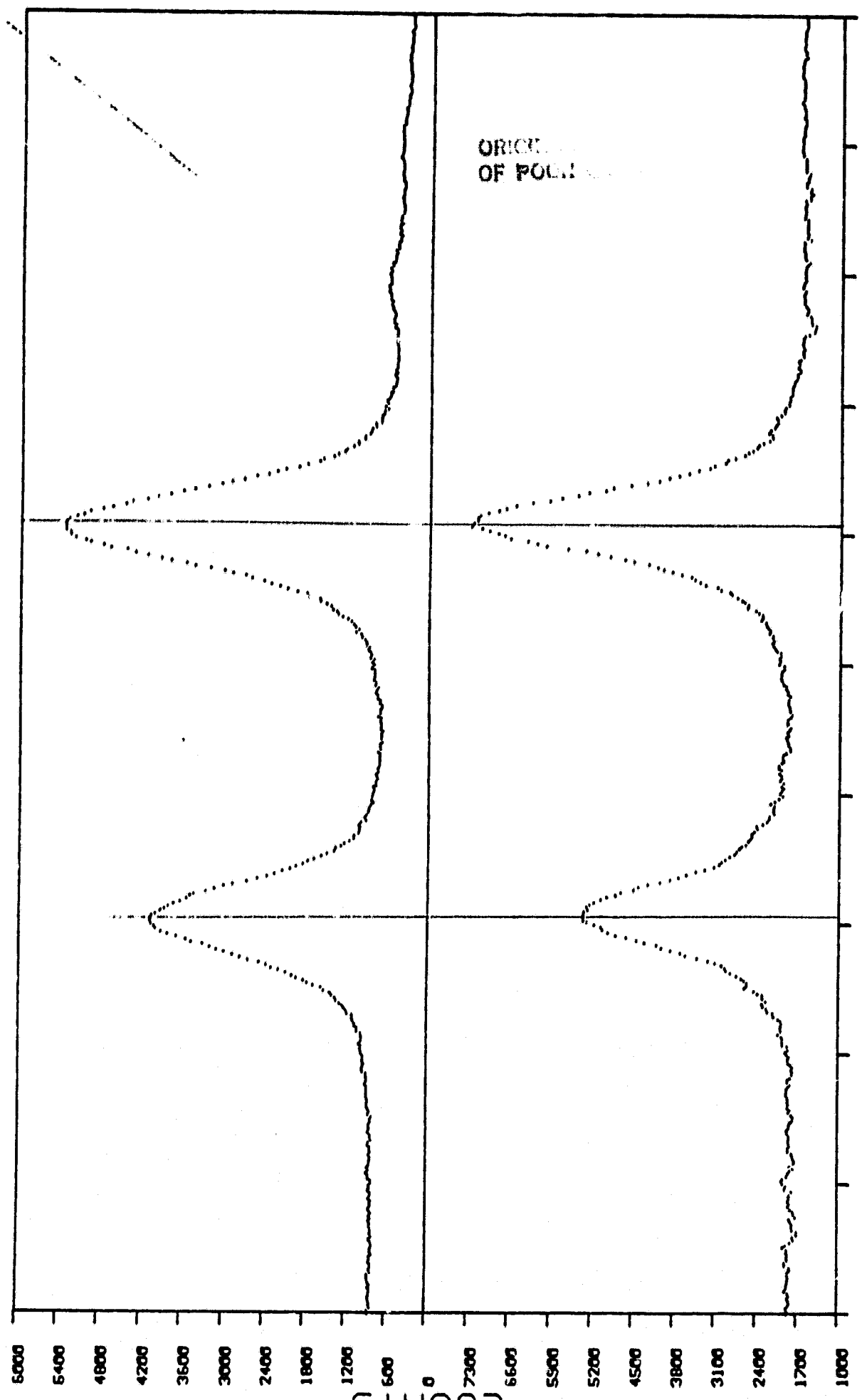


CHANNELS

2d 2x10<sup>3</sup>/1 AUF1  
2d 1x10<sup>3</sup>/1 AUC1

Fig. 1

# Au-PLATED Ag ASHED/CONTROL SPUT. - Ag 3d3/2 and 3d5/2



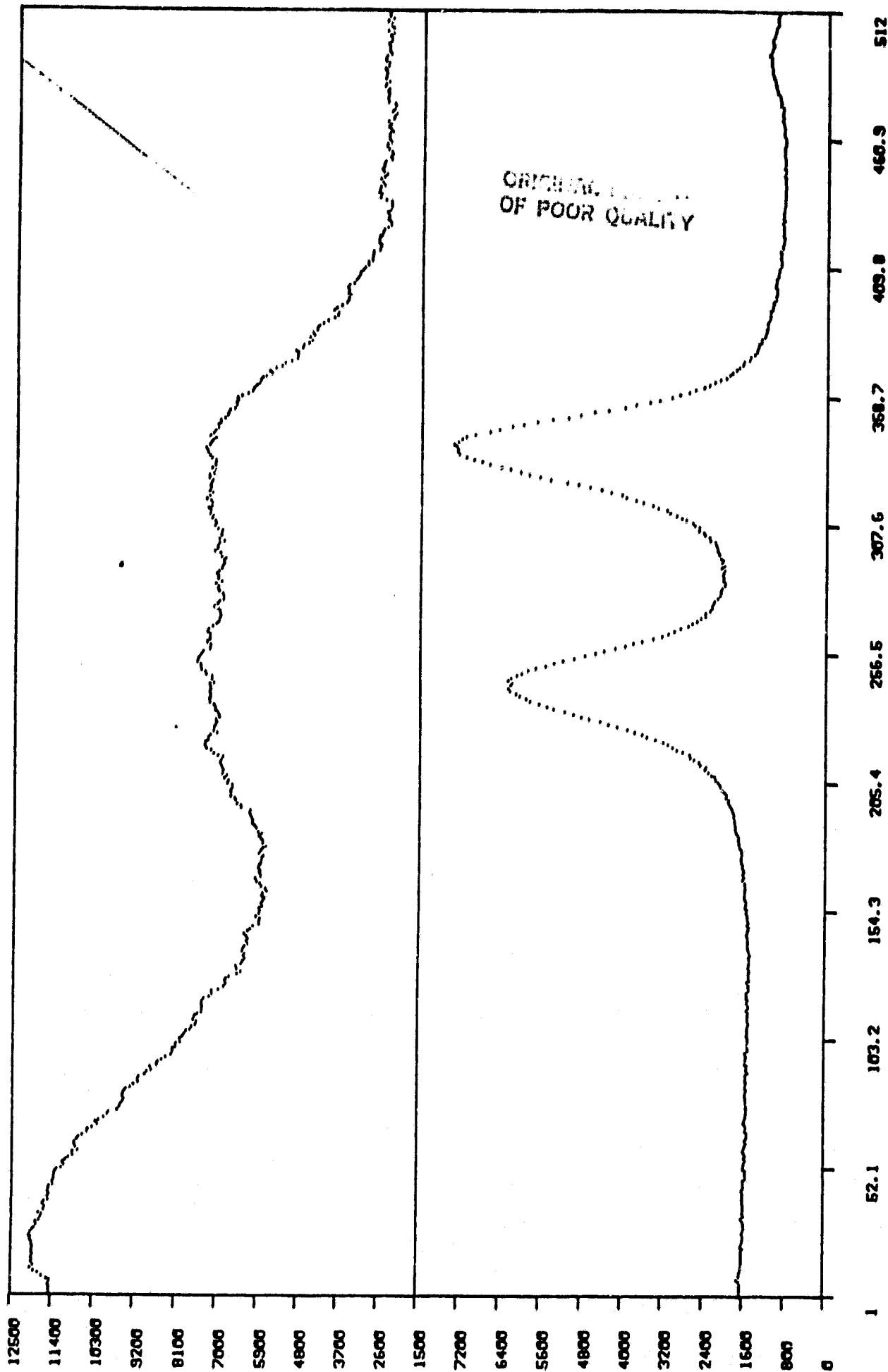
1 52.1 103.2 154.3 205.4 266.5 367.6 469.9 512

CHANNELS

Fig. 2

20 50 100 150 200 250 300 350 400 450 500 550 600 650 700 750 800 850 900 950 1000

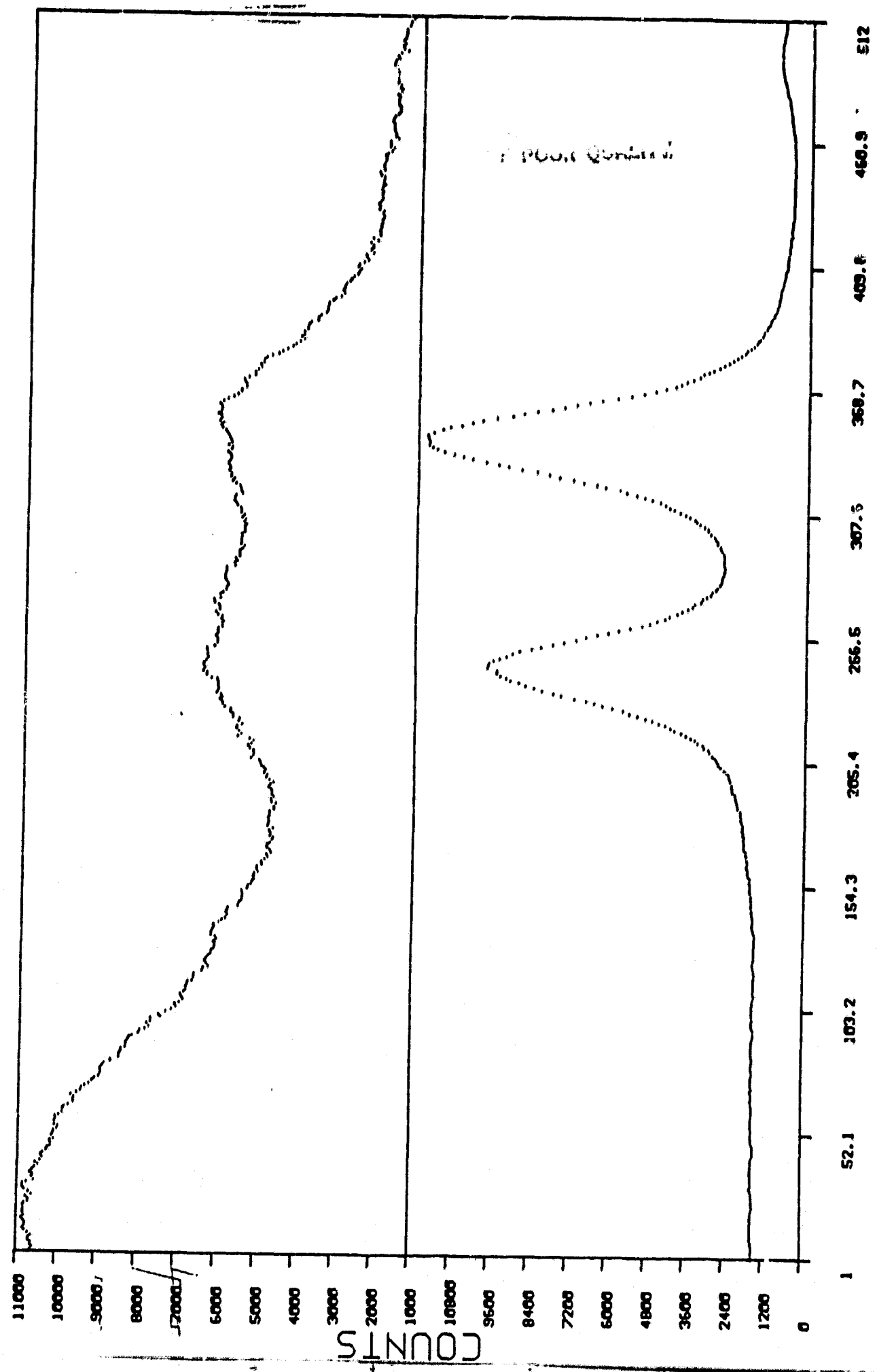
Au-PLATED Ag ASHED/CONTROL - Au 4f 5/2 and 4f 7/2



CHANNELS

200 1X10<sup>10</sup>/S AUF<sup>4</sup>  
50 1X10<sup>10</sup>/S AUF<sup>4</sup>

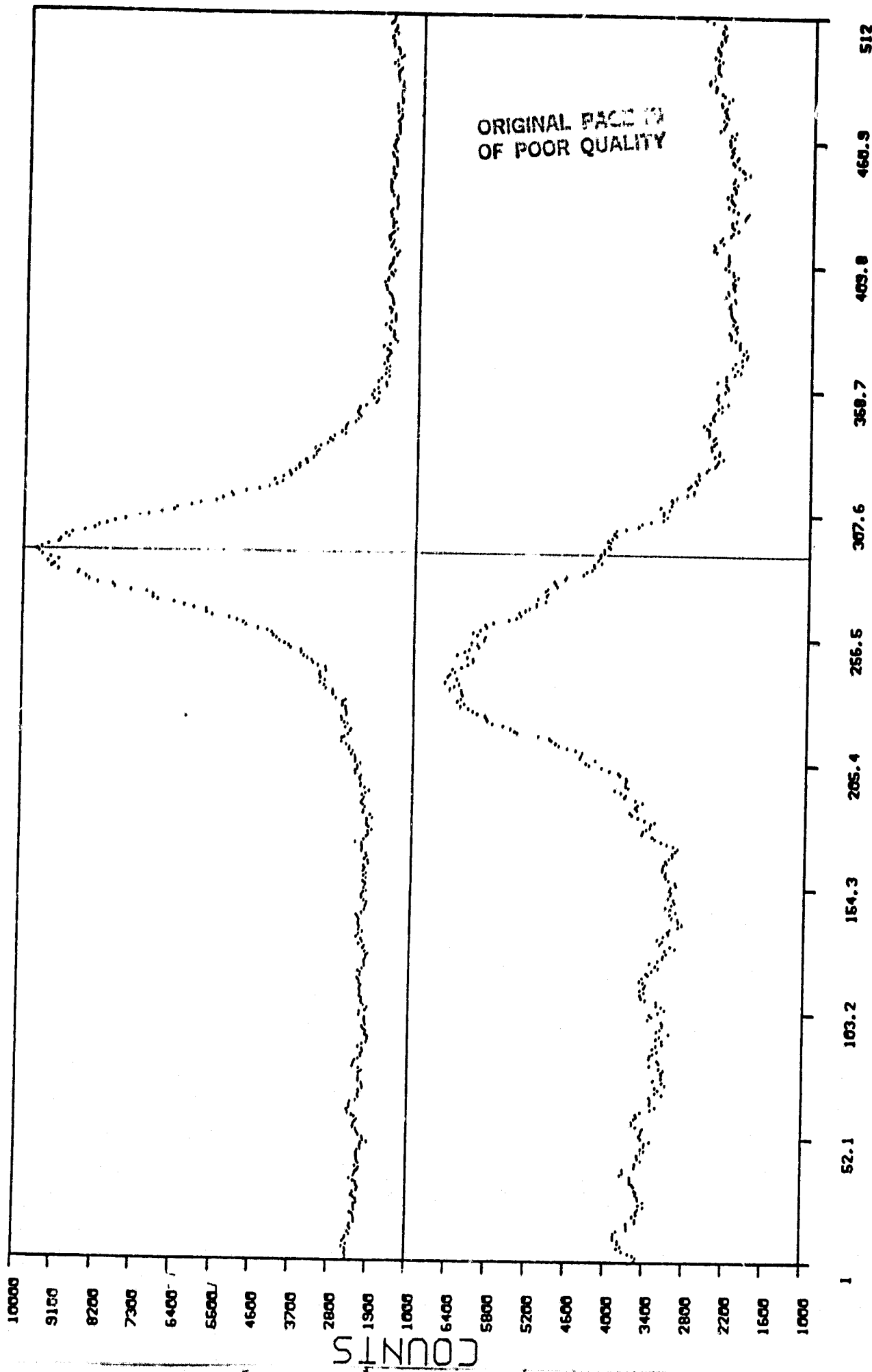
AU-PLATED Ag ASHED/CONTROL SPUT. - Au 4f5/2 and 4f7/2.



CHANNELS

200 1x10<sup>4</sup> e<sup>-</sup> AuF8  
2. 10<sup>4</sup> e<sup>-</sup> AuF8

# Au-PLATED Ag ASHED/CONTROL - 0 1s

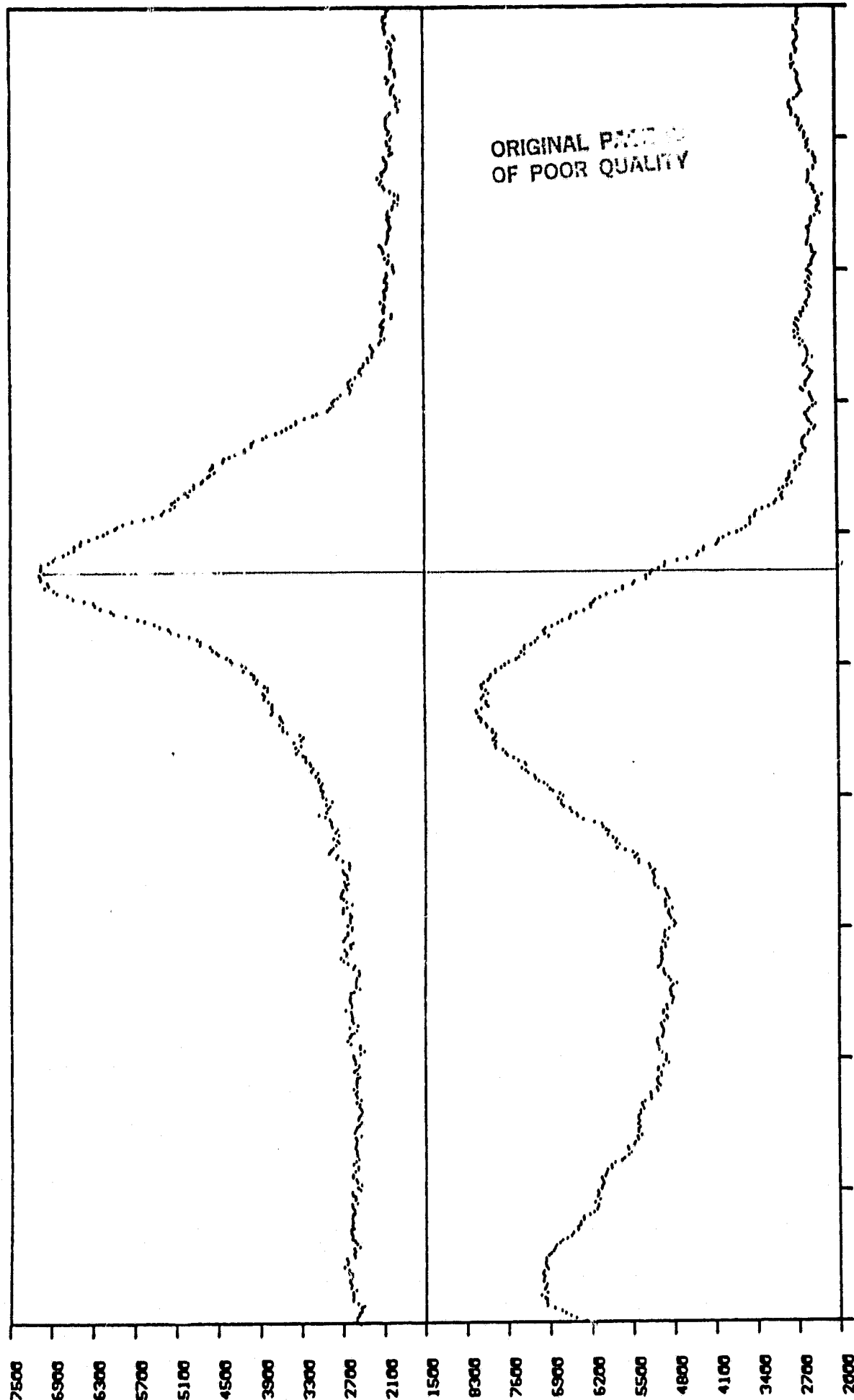


CHANNELS

5 0 5

50 241031 AUF 2  
AUC 3

# AU-PLATED Ag ASHED/CONTROL (SPUTTERED) - 0 1s

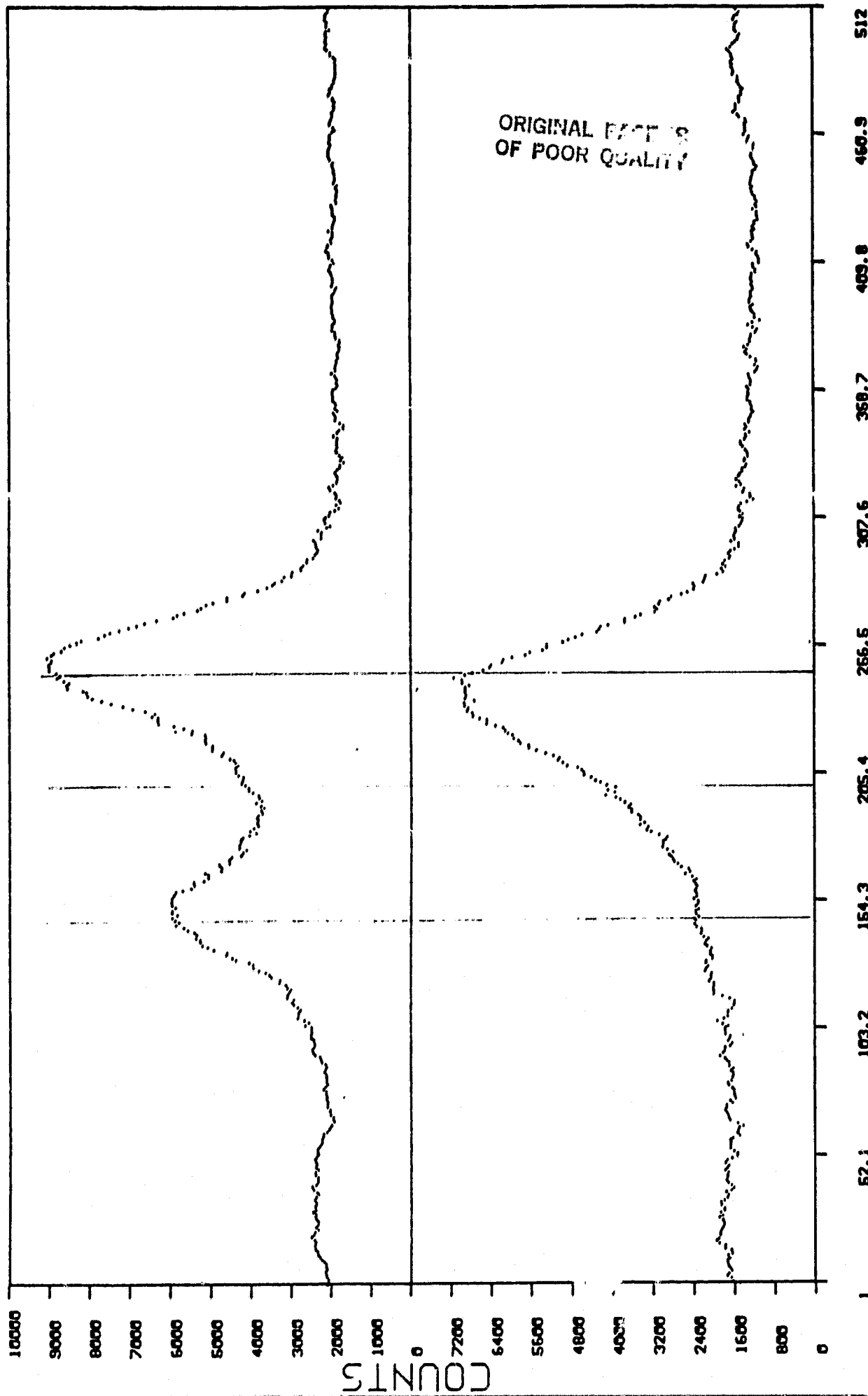


50 2X10<sup>3</sup>/1 AUFU

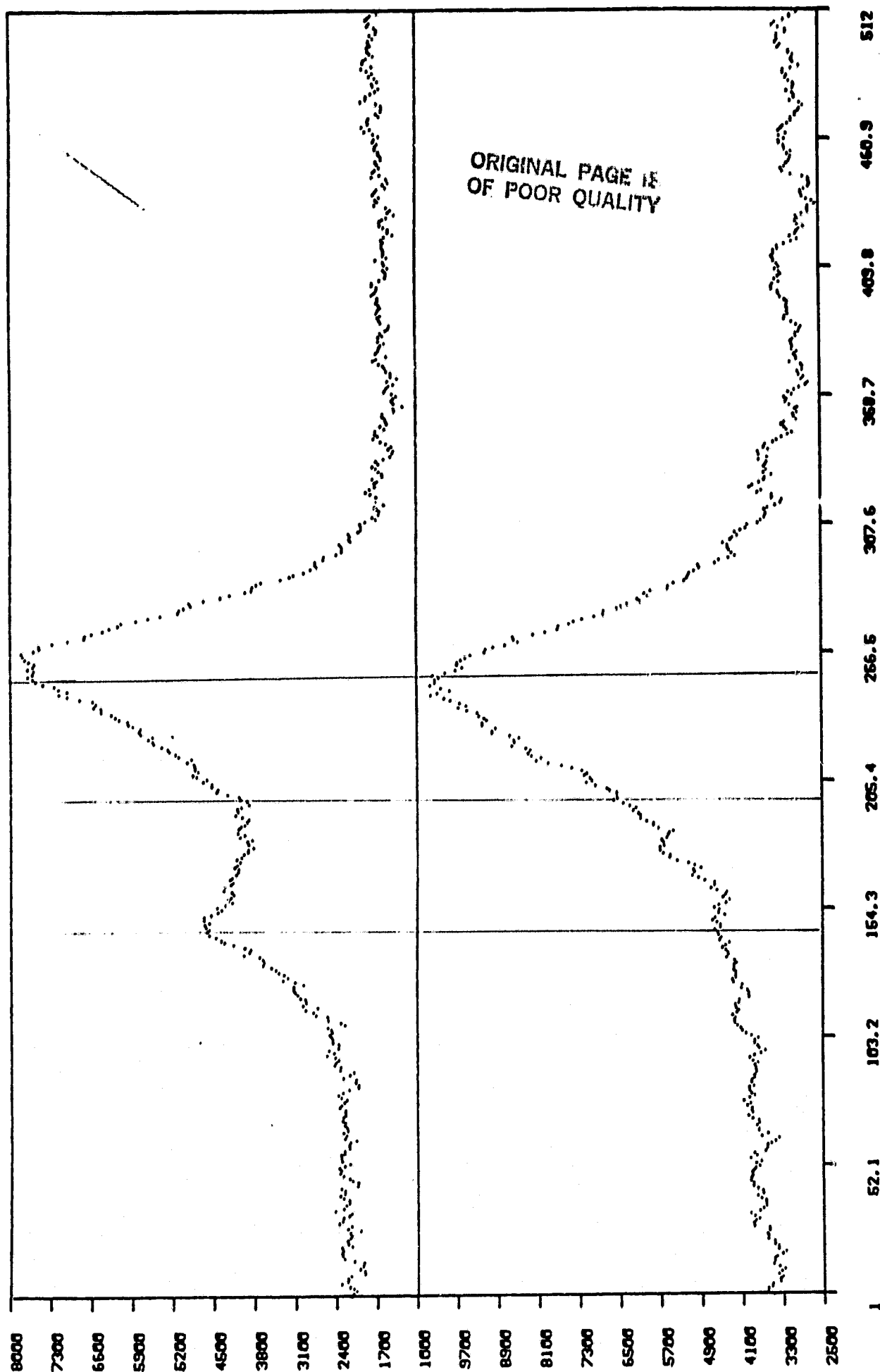
1000 24000/10



Au-PLATED Ag ASHED/CONTROL - C 1s



# AU-PLATED Ag ASHED/CONTROL (SPUTTERED) - C 15



CHANNELS

50 1X10<sup>3</sup>/2 AUF7  
50 2X10<sup>3</sup>/5 AUCL8

Sample: Silver foil. Asked 60 S  
 Treatment:  
 Date:

scan	peak	B.E. (eV)	ch. #	inten.	E <sub>0</sub> (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
AG-A607	Ag 2d <sub>3/2</sub>											
	Ag 2d <sub>5/2</sub>	347.9	310.2	$7 \times 10^3 / 1$	20	7000	340,000	$3.4 \times 10^7$	15 Å	10.7	0.20	Ag
AG-A601	O(1s)	531.2	284	$5 \times 10^3 / 5$	50	2000			14 Å	2.85		
		539.8	333									
							982,000	$1.9 \times 10^7$			0.47	O
AG-A602	C(1s)	284.6	175.7	$5 \times 10^3 / 1$	50				15 Å	1.00		
		284.6	241									
							480,000	$4.8 \times 10^6$			0.33	C

Comments:

$$\frac{Ag}{O} = \frac{1}{2}$$

elements: Ag, O, C, Ta

Figures:

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Sample: silver foil  
 Treatment:  
 Date:

scan	peak	B.E. (eV)	ch. #	inten.	E <sub>0</sub> (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
Ag-FC2	Ag 2/52											
	Ag 2/52	308.2	302.5	$2 \times 10^3 / 1$	40	4500	293,000	$2.93 \times 10^7$	15 Å	10.7	0.15	Ag
Ag-FC1	Ag 2/52	532.4	246.3	$5 \times 10^3 / 5$	50	6000	367,000	$7.34 \times 10^6$	14 Å	2.85	0.15	O
Ag-FC3	C 1/28	284.8	236	$2 \times 10^3 / 1$	50	6000	320,000	$1.28 \times 10^7$	15 Å	1.00	0.70	C

Comments:  $\frac{Ag}{O} = 1$

elements: Ag, O, C, Ta

Figures:

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# SILVER ASHED 60 SEC./CONTROL - Ag 3d 3/2 and 3d 5/2

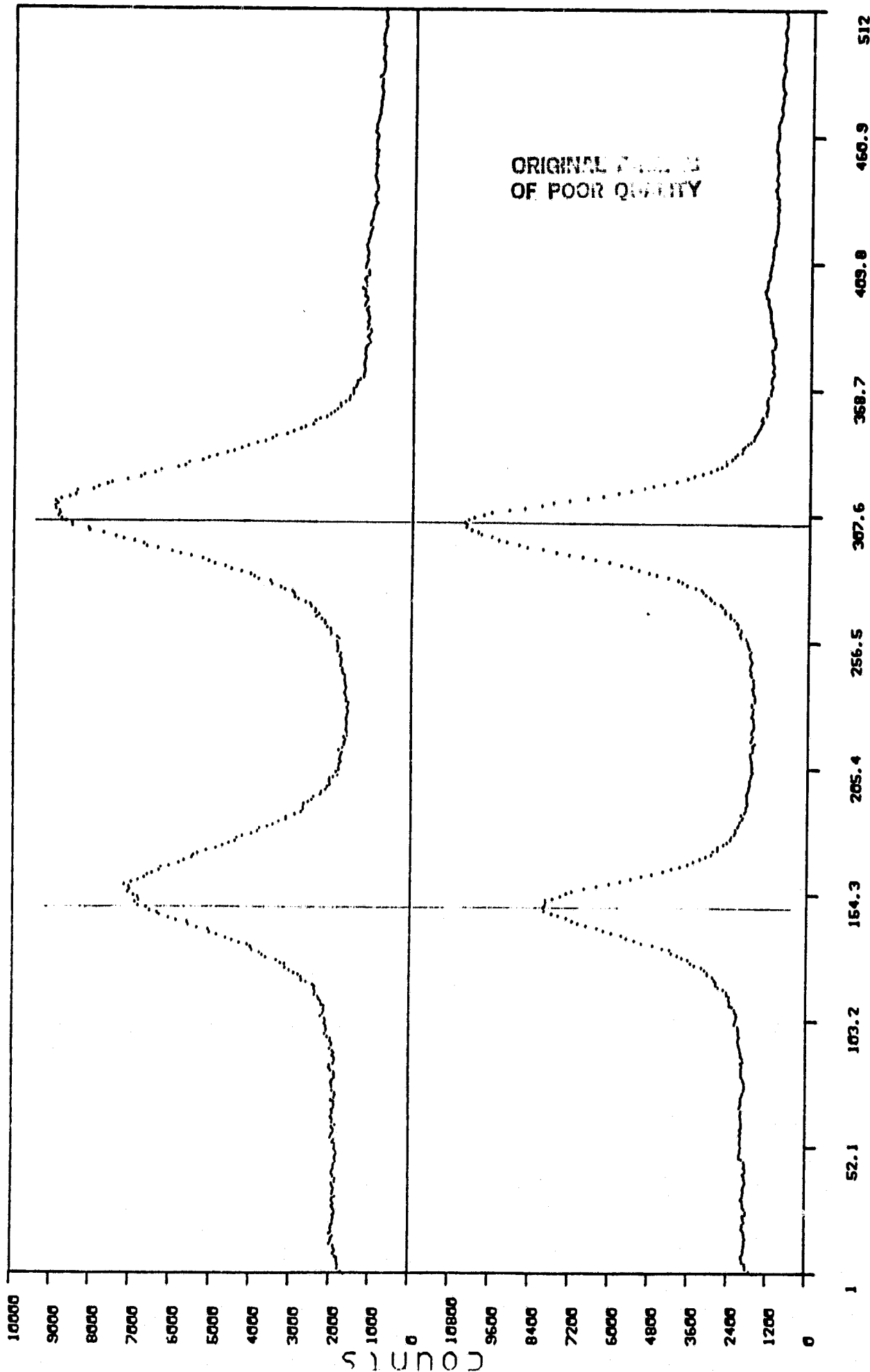
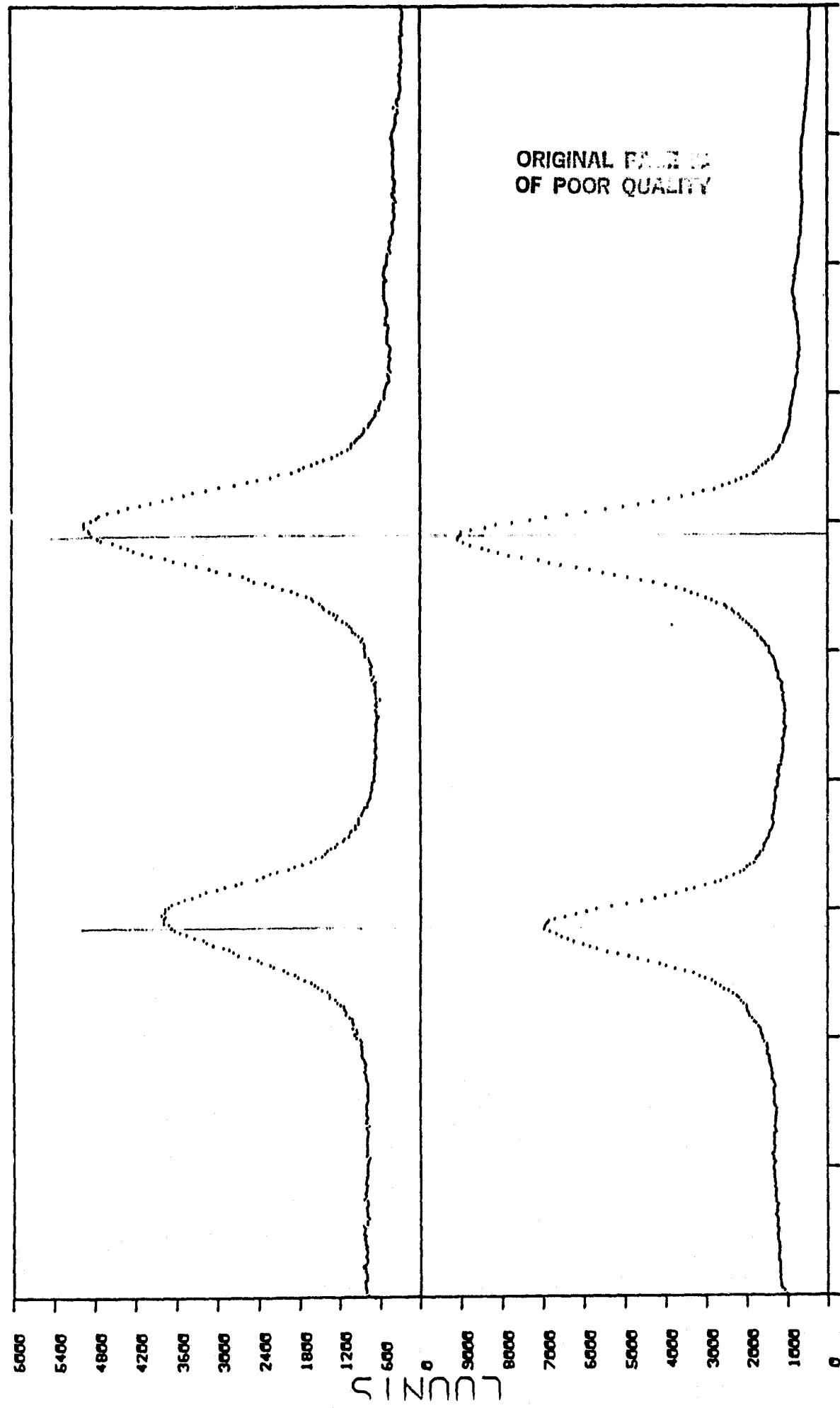


Fig 9

20 2X 3/4  
70 2X 3/4  
AGAF2  
ACFC2

# Ag ASHED/CONTROL (SPUTTERED) - Ag 3d 3/2 & 3d 5/2



1 52.1 163.2 154.3 205.4 255.5 307.6 368.7 409.8 460.9 512

CHANNELS

20 SX103/1 AG-A605  
20 SX103/1 AG-FC5

SILVER ASHED 60 SEC. CONTROL - 0 (1s)

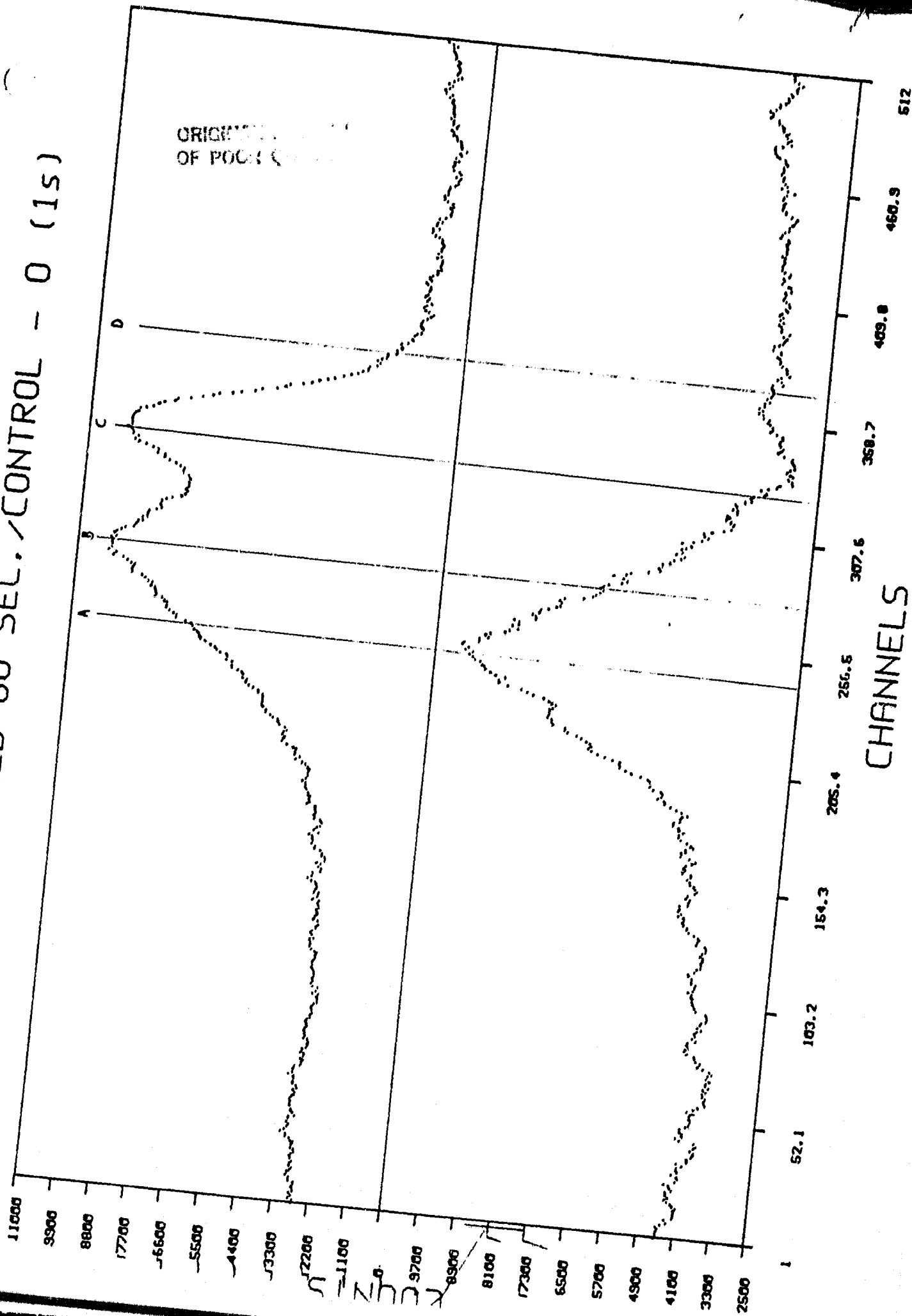
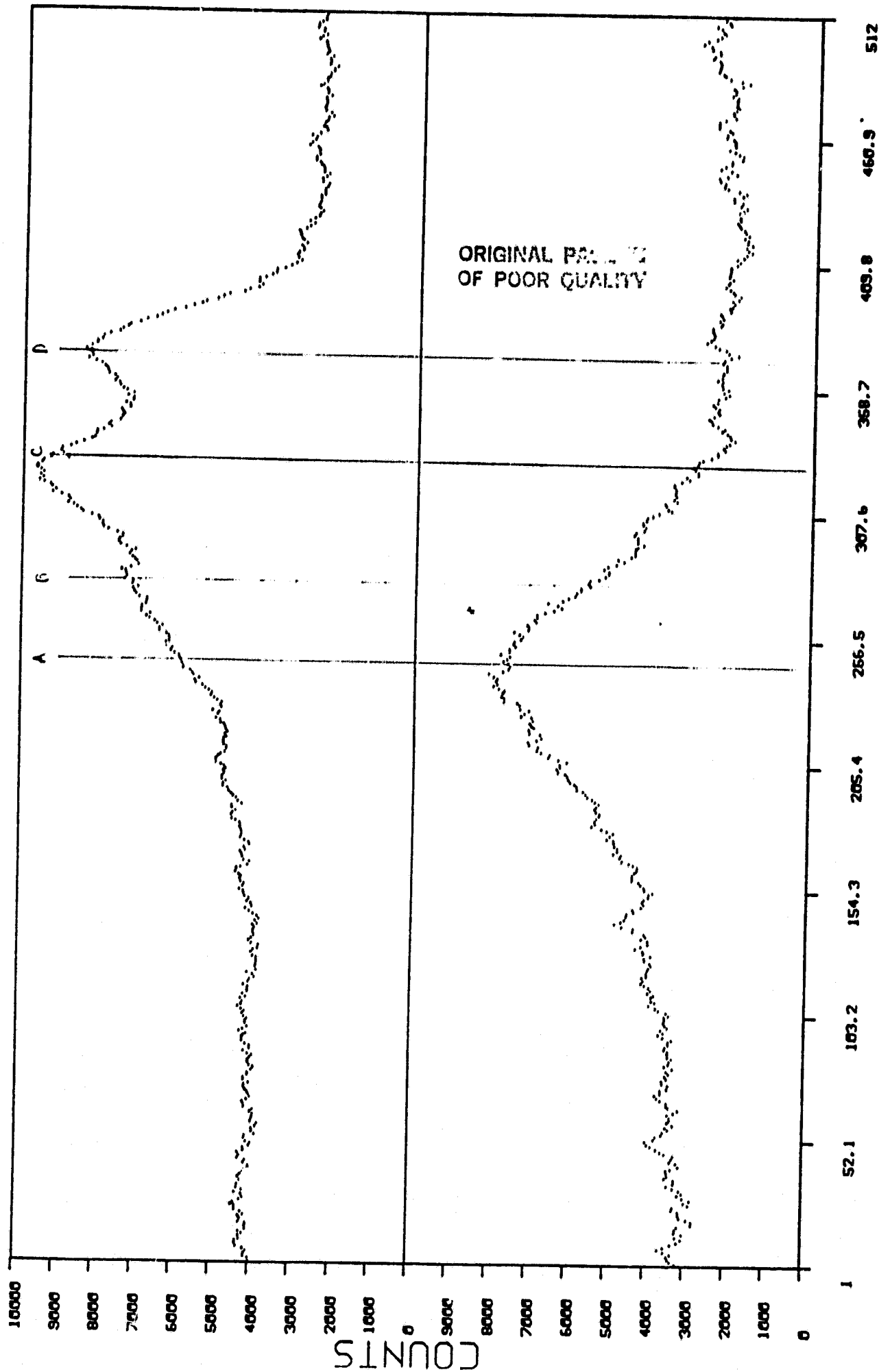


Fig 11

SO SX10/S AG-2.601  
SO SX10/S AG-2.601

# SILVER ASHED 60 S/CONTROL (SPUTTERED) - 0 (1s)



CHANNELS

SD 5X10<sup>2</sup>/1 AGA604  
 120 7X10<sup>2</sup>/20 AGFC4

Fig 12



# SILVER ASHED 60 SEC./CONTROL - C (1s) peak

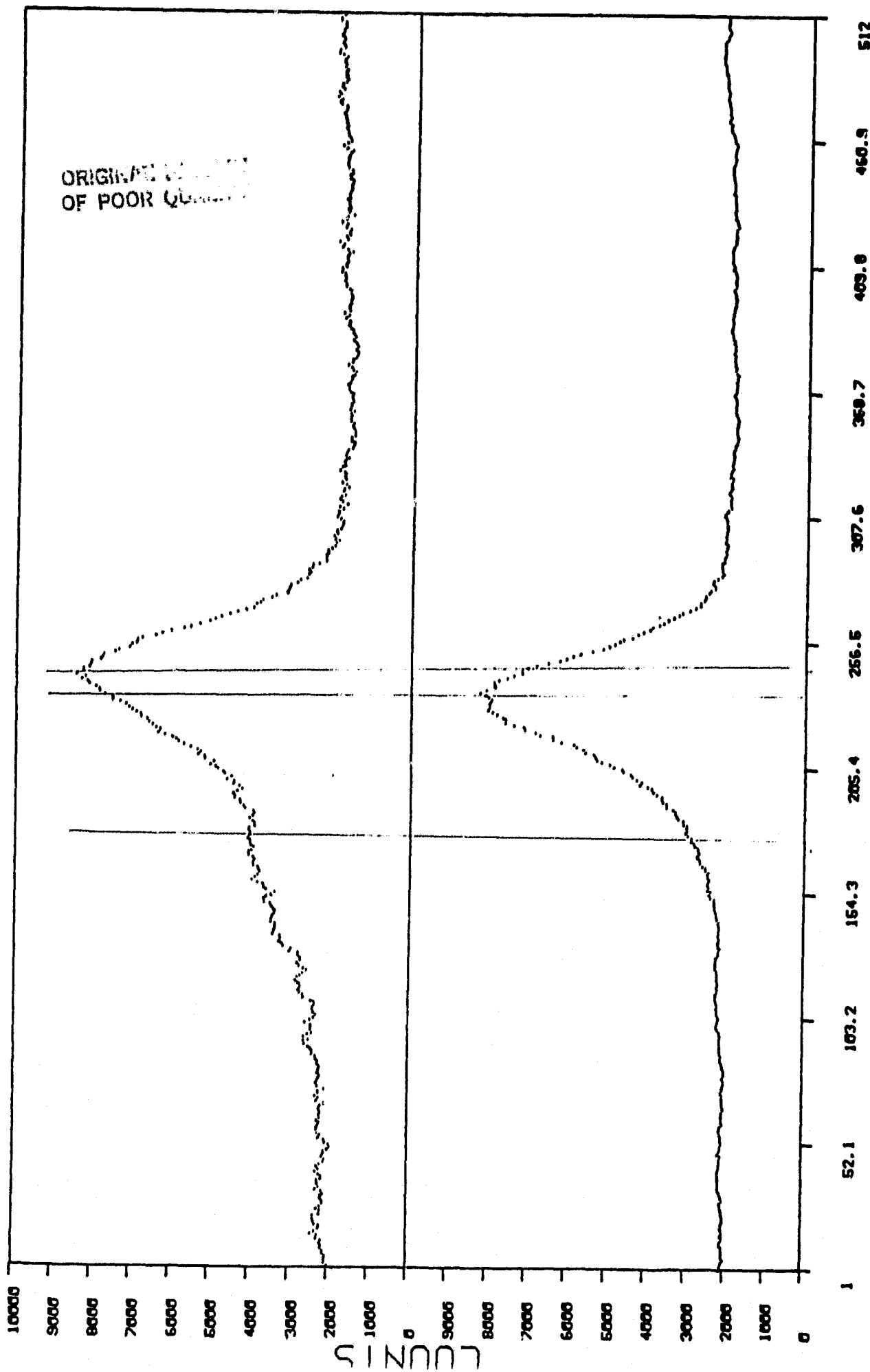
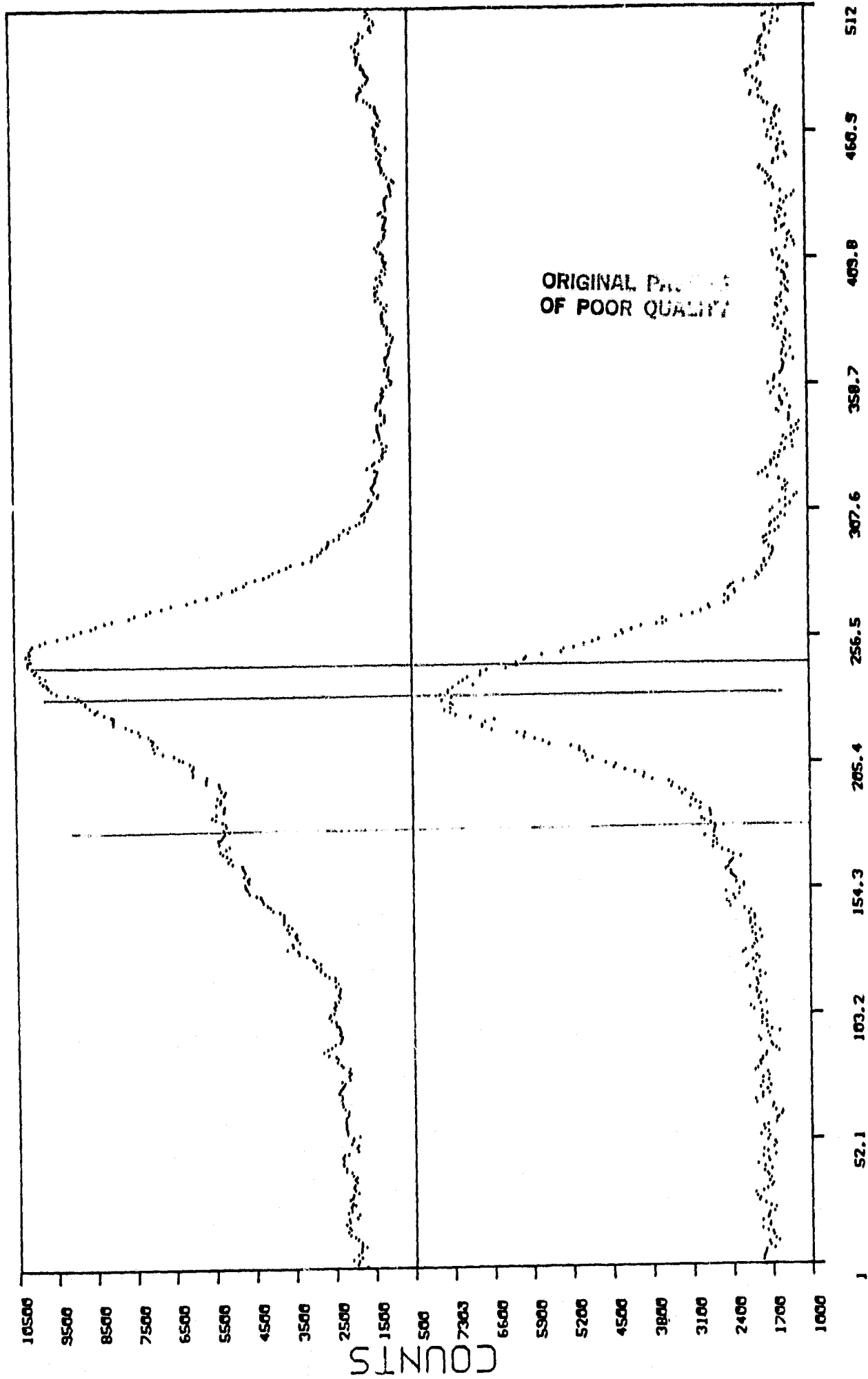


Fig 13

# SILVER ASHED/CONTROL (SPUTTERED) - C 15



CHANNELS

Fig. 14

20 5519 7/2 ACA 600  
50 1x10 3/1 AGFC6

Sample: STS-8 Flight  
 Treatment:  
 Date: 8-1-84

scan	peak	B.E. (eV)	ch. #	inten.	E <sub>0</sub> (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
STS8	A <sub>9</sub> 31.5	374		2x10 <sup>9</sup> /1	50	6000						
	A <sub>9</sub> 30.5	368	308			6000	245,000	9.8x10 <sup>7</sup>	15 Å	10.7	0.40	A <sub>9</sub>
STS84	C (1s)	532.2	251	5x10 <sup>3</sup> /5	50	3000			14 Å	2.85		
		530.4	297			5600						
						total	472,000	9.44x10 <sup>8</sup>			0.16	O
STS83	C (1s)	286.9	249.45	5x10 <sup>3</sup> /5	50	800			15 Å	1.00		
		284.3	249			7000						
						total	506,000	1.012x10 <sup>9</sup>			0.44	C

Comments:

elements: Ag, Cu, Al, S, Ta

Figures:

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Sample: STS-8 Control  
 Treatment:  
 Date: 8-1-84

scan	peak	B.E. (eV)	ch. #	inten.	$E_0$ (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
STSC1	Ag 3/2	374		$1 \times 10^4/1$	50							
	Ag 2/2	368	308				273,000	$5.46 \times 10^7$	15 Å	10.7	0.19	Ag
STSC2	C(1s)	532.2	251	$8 \times 10^3/5$	50		726,000	$1.454 \times 10^7$	14 Å	2.85	0.20	O
STSC3	C(1s)	286.7	188.7	$5 \times 10^3/2$	50	1500			15 Å	1.00		
		284.7	238.7			6500						
						total	332,000	$1.66 \times 10^7$			0.61	C

Comments:

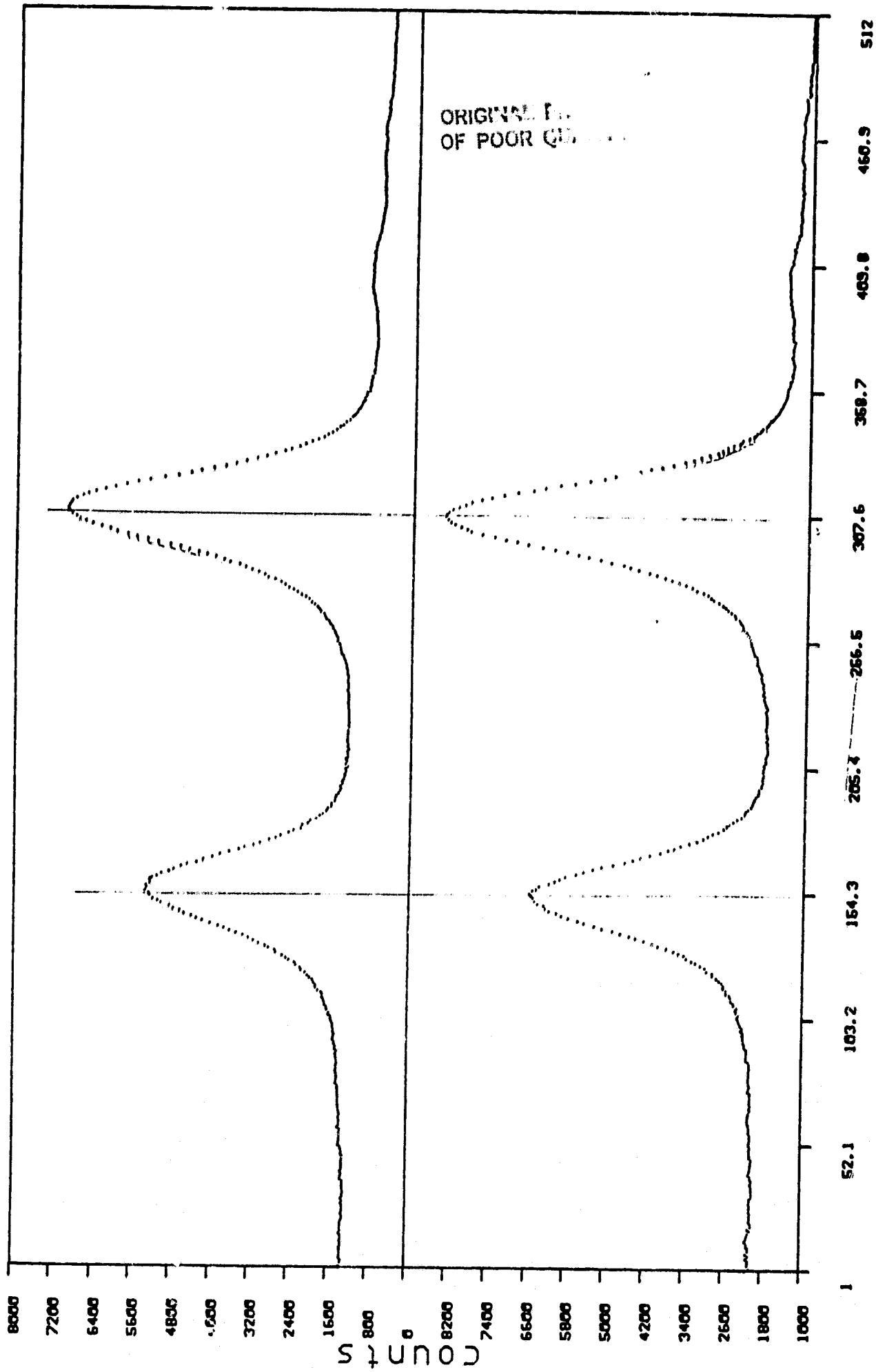
Ag 2/2  $\Rightarrow$  Ag

elements: Ag, C, O, Cl, S, Ta

Figures:

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# STS-8 FLIGHT/CONTROL - Ag 3d 3/2 and 3d 5/2



channels

Fig 15

50 2x10<sup>4</sup> STS-8  
10 1x10<sup>4</sup> STS-8

# STS-8 FLIGHT/CONTROL SPUT.- Ag 3d 3/2 and 3d 5/2.

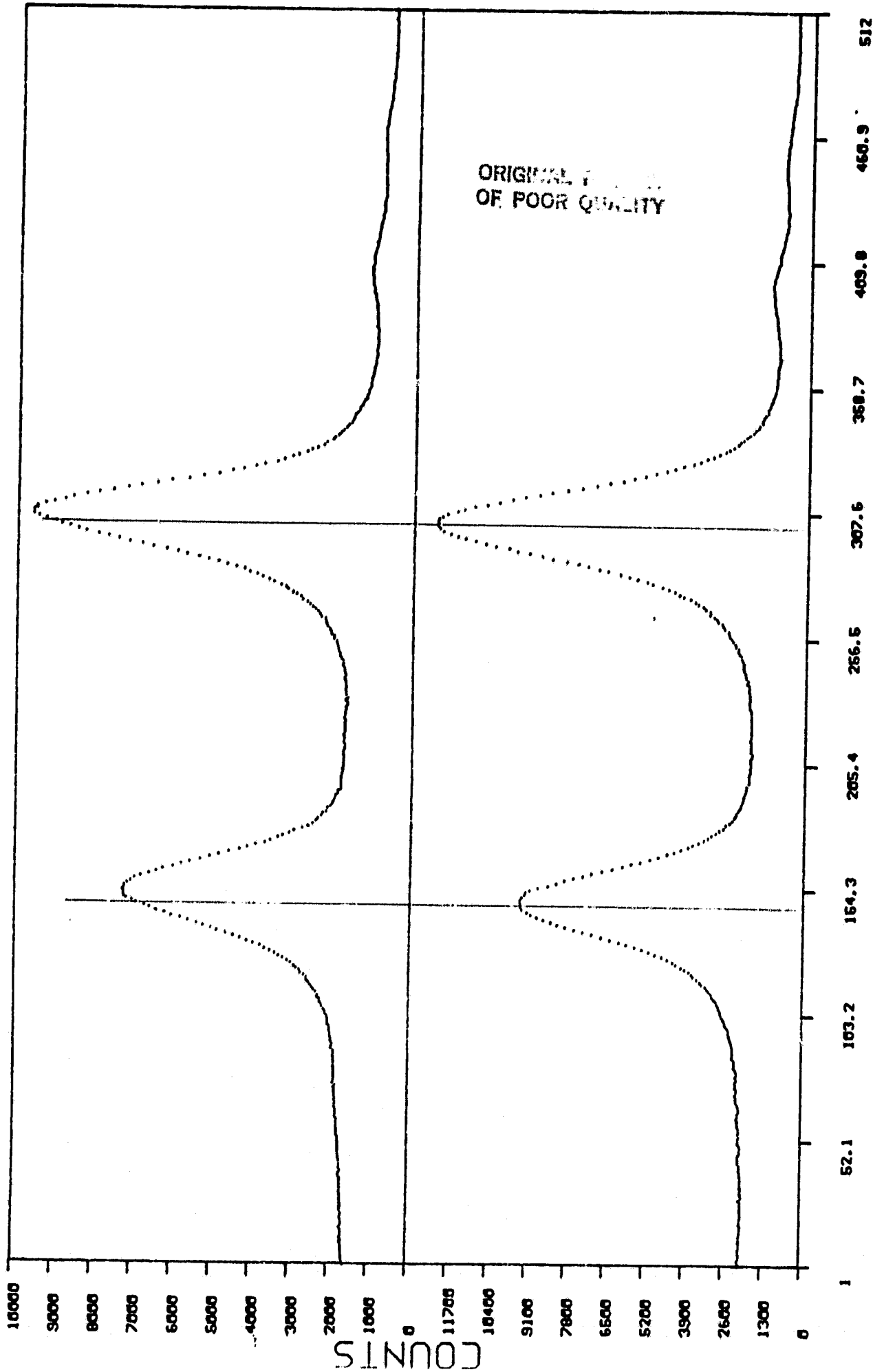


Fig. 10

70 200% 07584  
60 100% 00000

# STS-8 FLIGHT/CONTROL - 0 1s

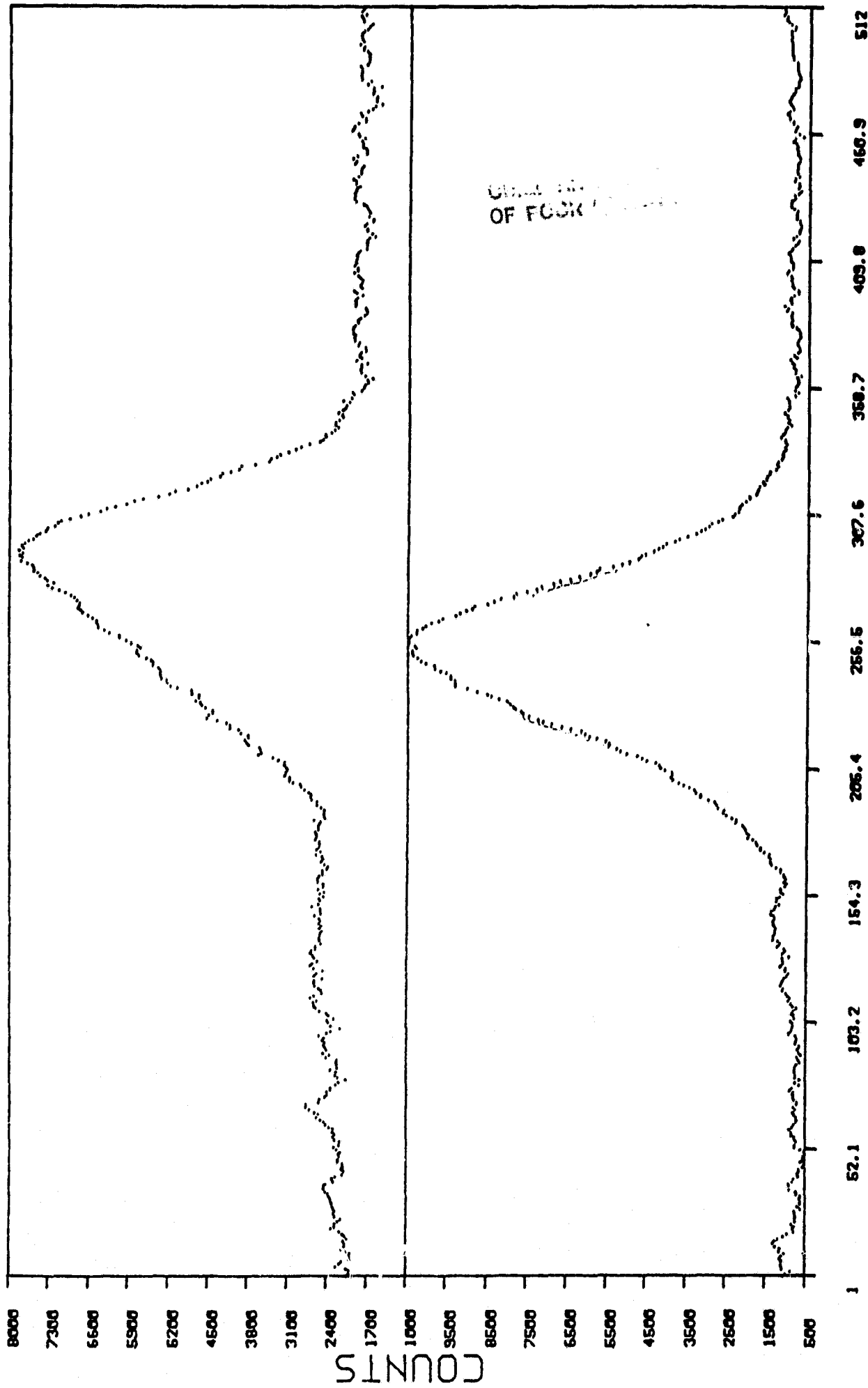
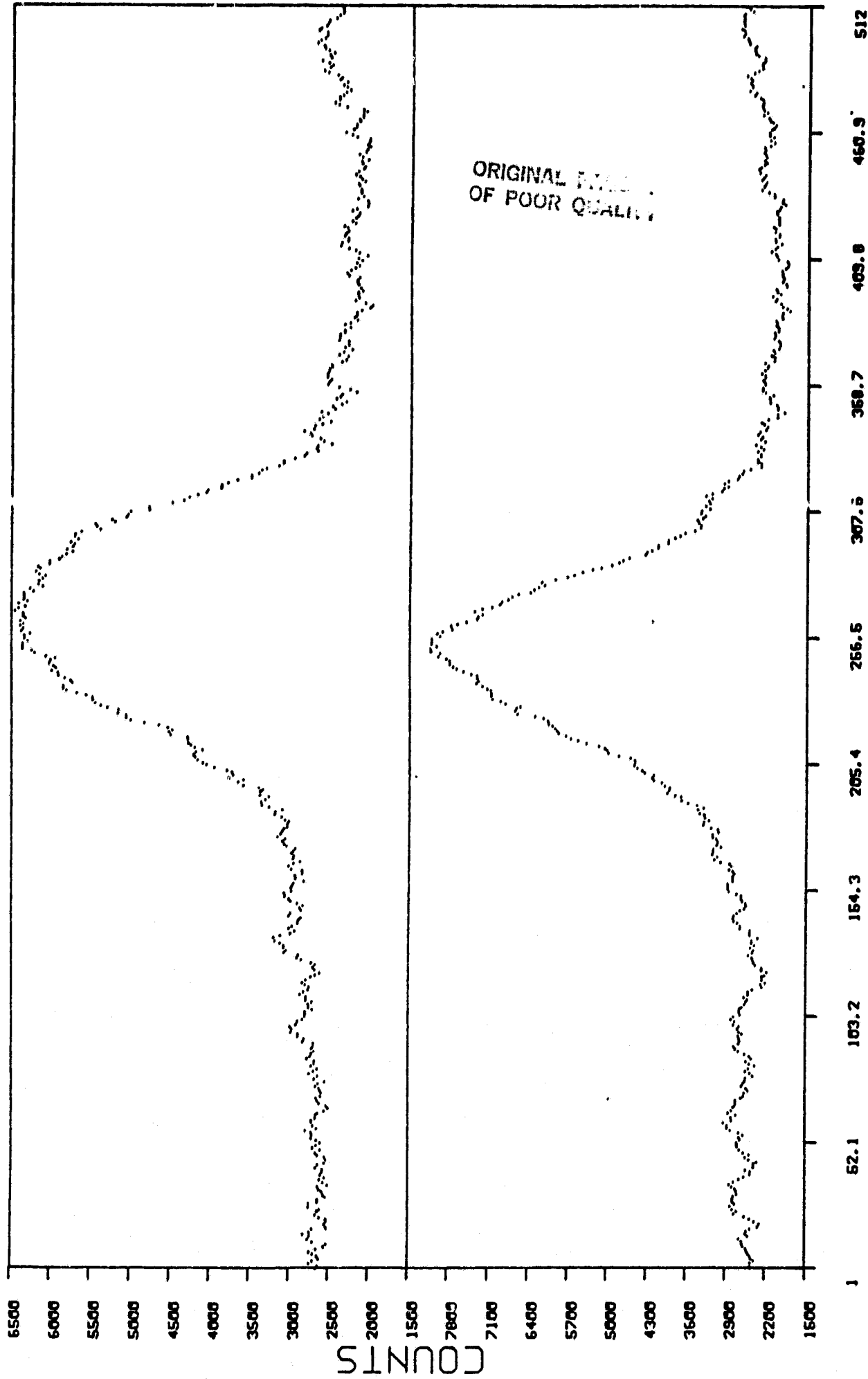


Fig 17

# STS-8 FLIGHT/CONTROL (SPUTTERED) - 0 1s



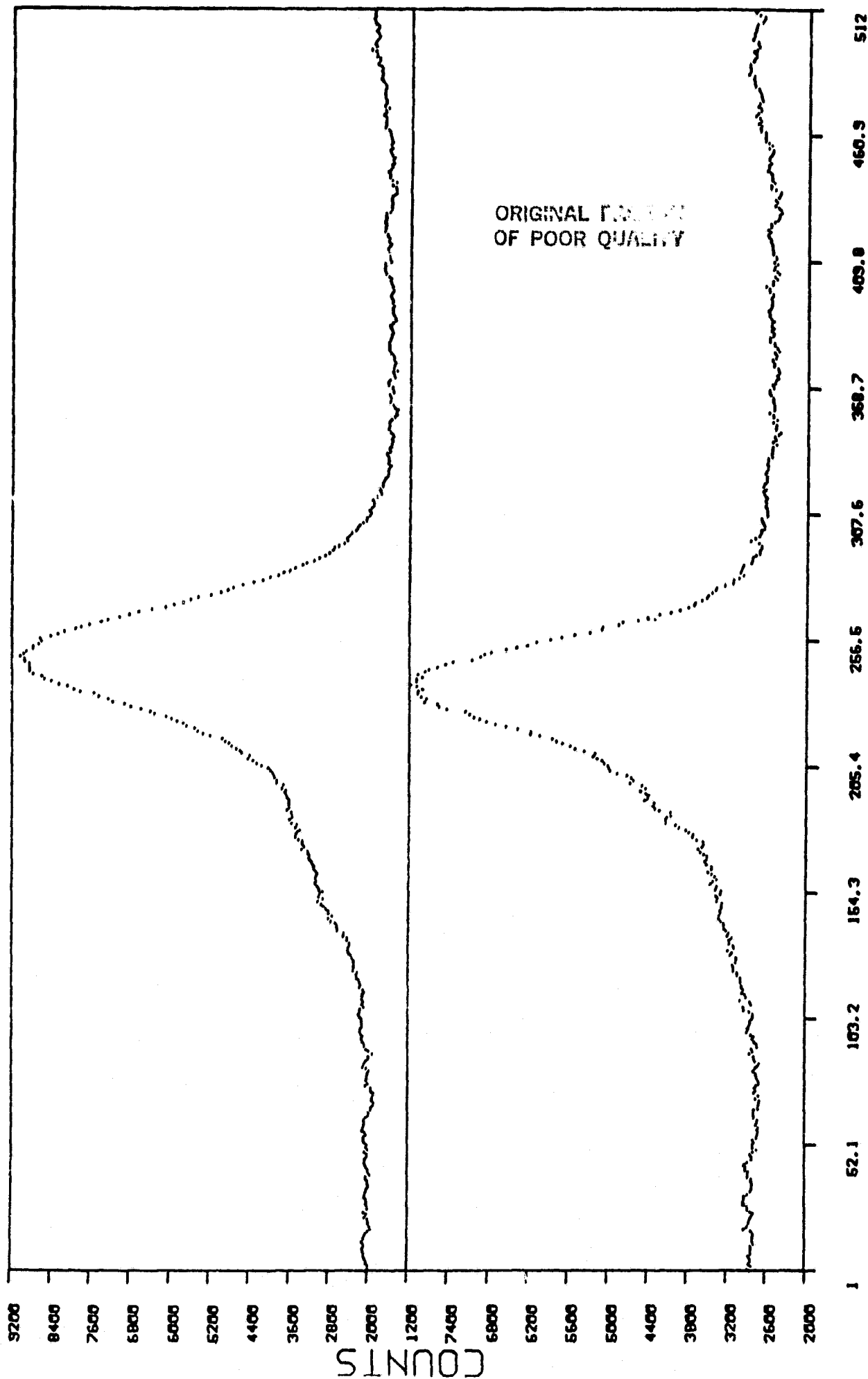
CHANNELS

Fig 18

50 5X103/5 STS85



# STS-8 FLIGHT/CONTROL - C 1s

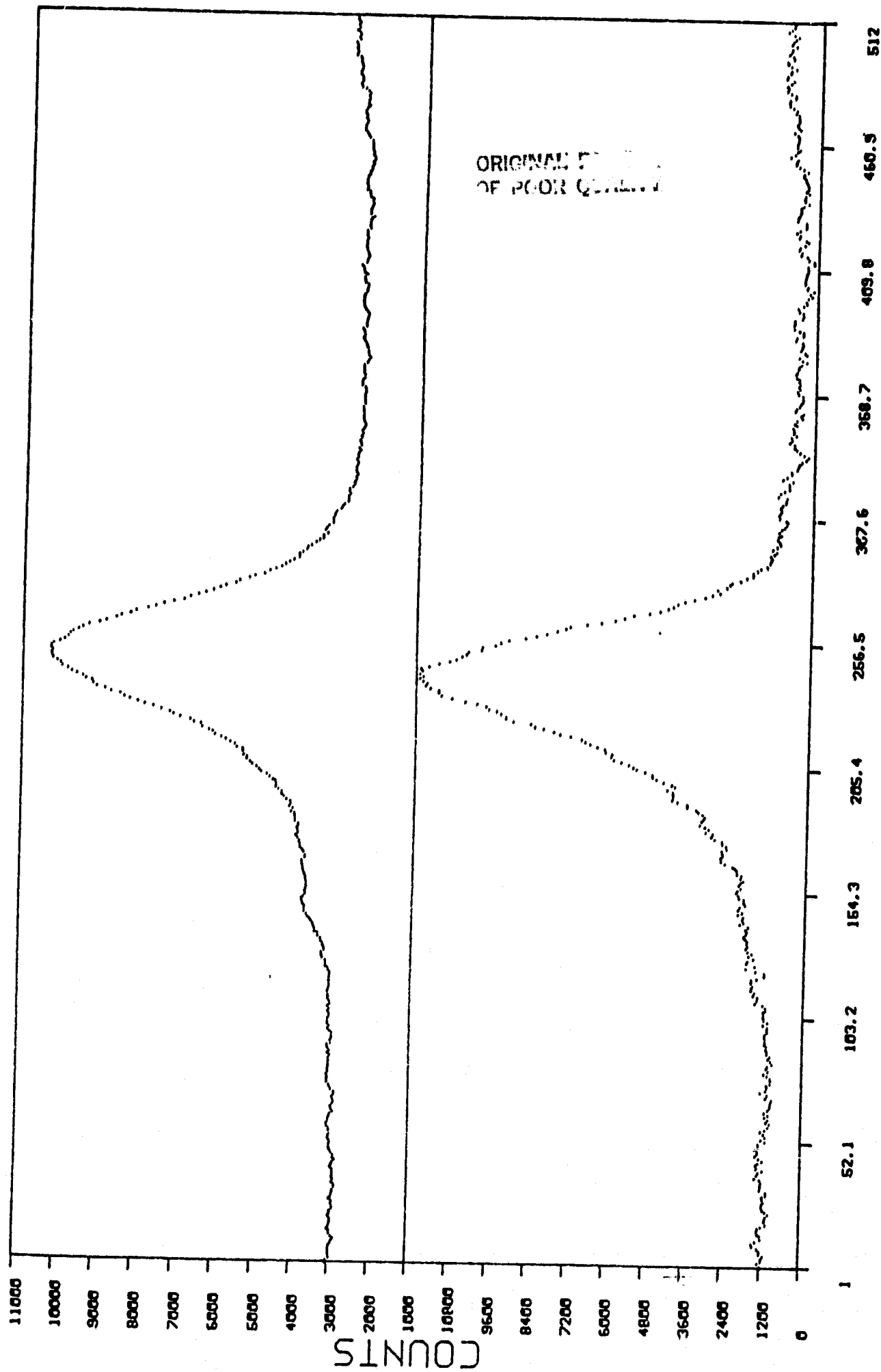


CHANNELS

Fig 19

SC 010716 STS83  
50 000000 000000

# STS-8 FLIGHT/CONTROL (SPUTTERED) - C 1s



CHANNELS

Fig 20

50 SAMPLES STS86  
50 SAMPLES STS87

Sample: Silver / Flight

Treatment:

Date: 7 89

scan	peak	B.E. (eV)	ch. #	inten.	E <sub>0</sub> (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
AG 3	Ag 3d <sub>5/2</sub>			$1 \times 10^{11}/1$	50							
	Ag 3d <sub>3/2</sub>	367.8	312.7				233,000	$4.66 \times 10^7$	15 Å	10.7	0.22	Ag
AG 5	O(1s)	532.2	251.4	$5 \times 10^{12}/2$	20	4550			14 Å	285		
		520.4	247.4			4550						
AG 4	C(1s)	285.7	213.1	$5 \times 10^{13}/5$	50	total 1700	632,000	$7.9 \times 10^6$	15 Å	1.00	0.15	O
		294.55	247.6			7000						
						total	613,000	$1.226 \times 10^7$			0.63	C

Comments:

Ag, O, C, Ta,

Figures:

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Sample: Silver / Control  
 Treatment:  
 Date: 7-27-89

scan	peak	B.E. (eV)	ch. #	inten.	E <sub>0</sub> (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
AGEBL2	Ag 3d5/2			$1 \times 10^{11}$	50							
	Ag 3d5/2	368.1	305			2000	47,500	$1.15 \times 10^7$	15 Å	10.7	0.16	Ag
AGBLS	O(1S)	532.2	251.4	$5 \times 10^{12}$	20	3000			14 Å	2.85		
		530.4	277.4			2000						
						total	386,000	$4.925 \times 10^6$				
AGEBL4	C(1S)	285.4	220.1	$5 \times 10^{13}$	50				15 Å	1.00	0.16	O
		284.4	246.3									
		282.8	287.2									
						total	399,000	$7.98 \times 10^6$			0.68	C

Comments:

$I_0 = 1 \Rightarrow \text{AgO}$

Ag, C, O, Ti, Cl

Figures:

# SILVER FLIGHT/CONTROL - Ag 3d 3/2 and 3d 5/2 peaks

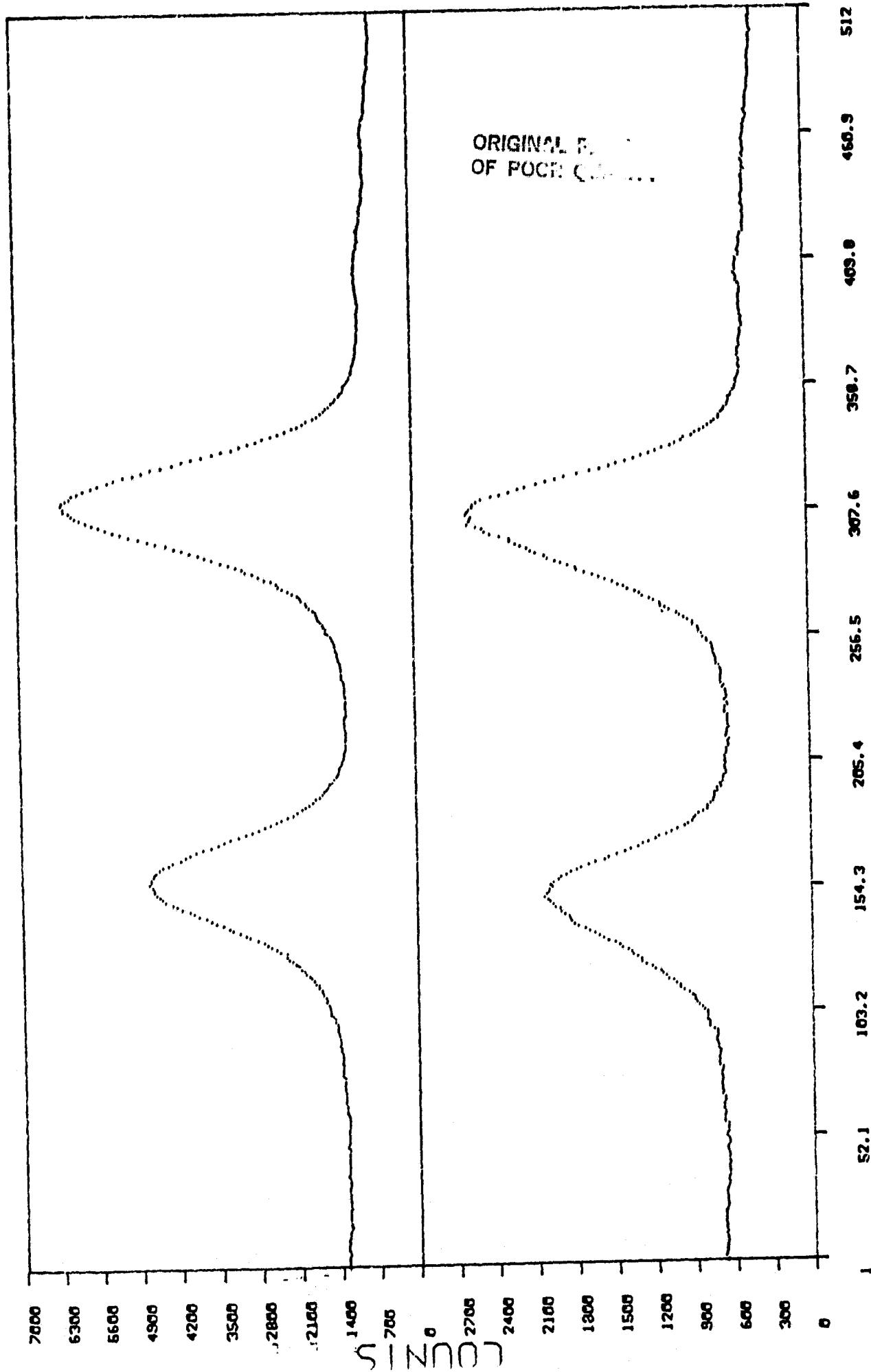
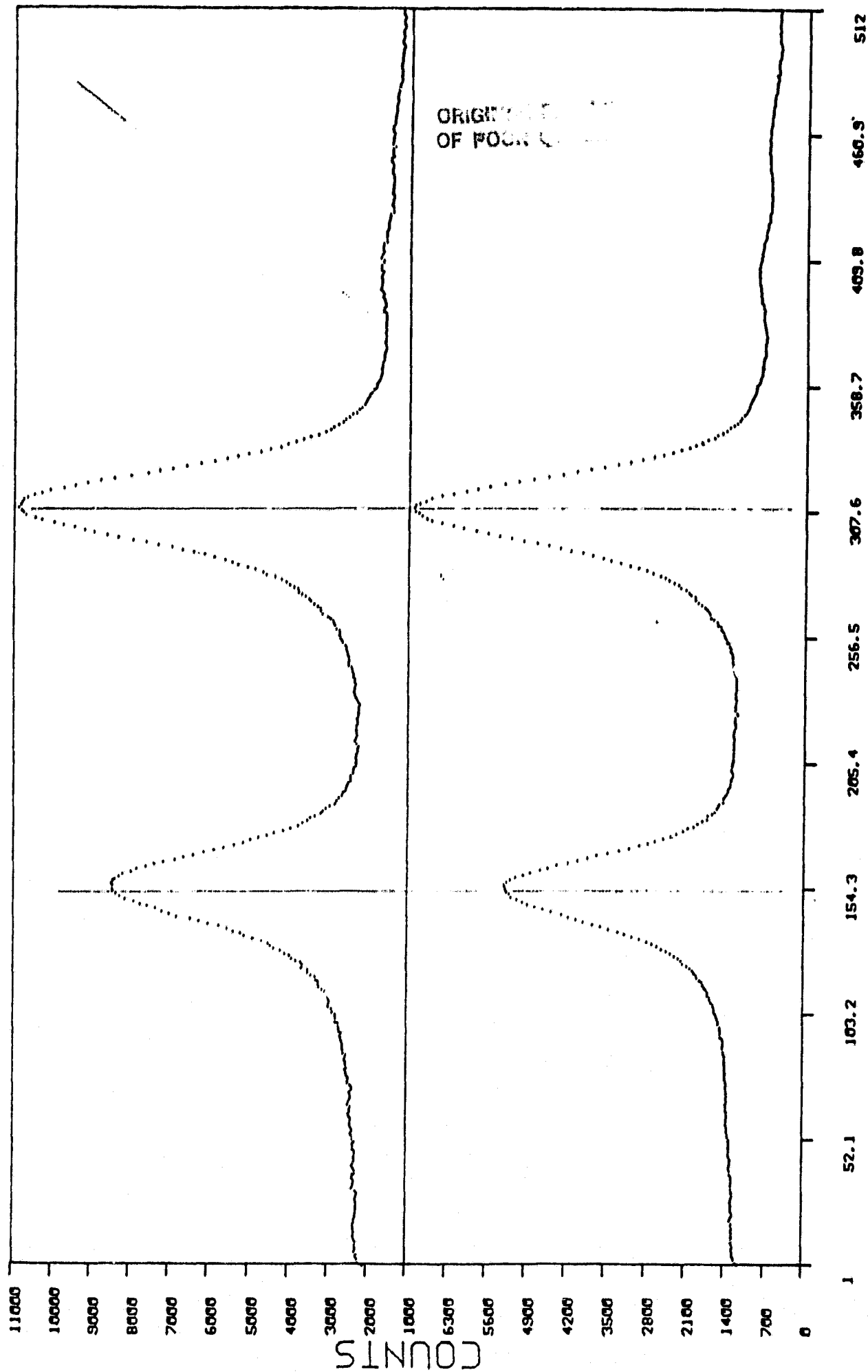


Fig 21

# Ag FLIGHT/CONTROL (SPUTTERED) - Ag 3d 3/2 and 3d 5/2

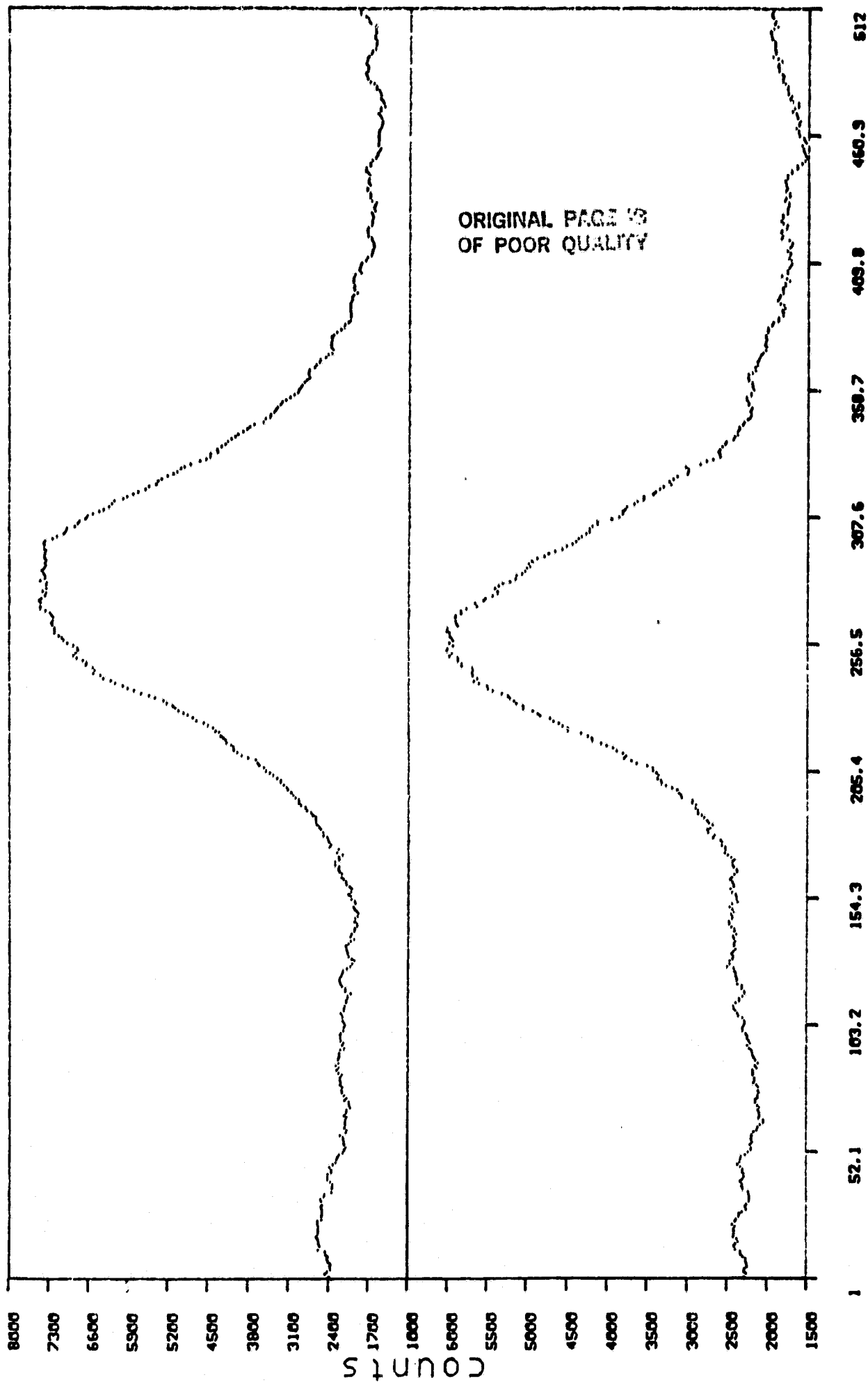


CHANNELS

Fig 22

SD 1x10<sup>11</sup>/1 de  
- cm<sup>3</sup>/s

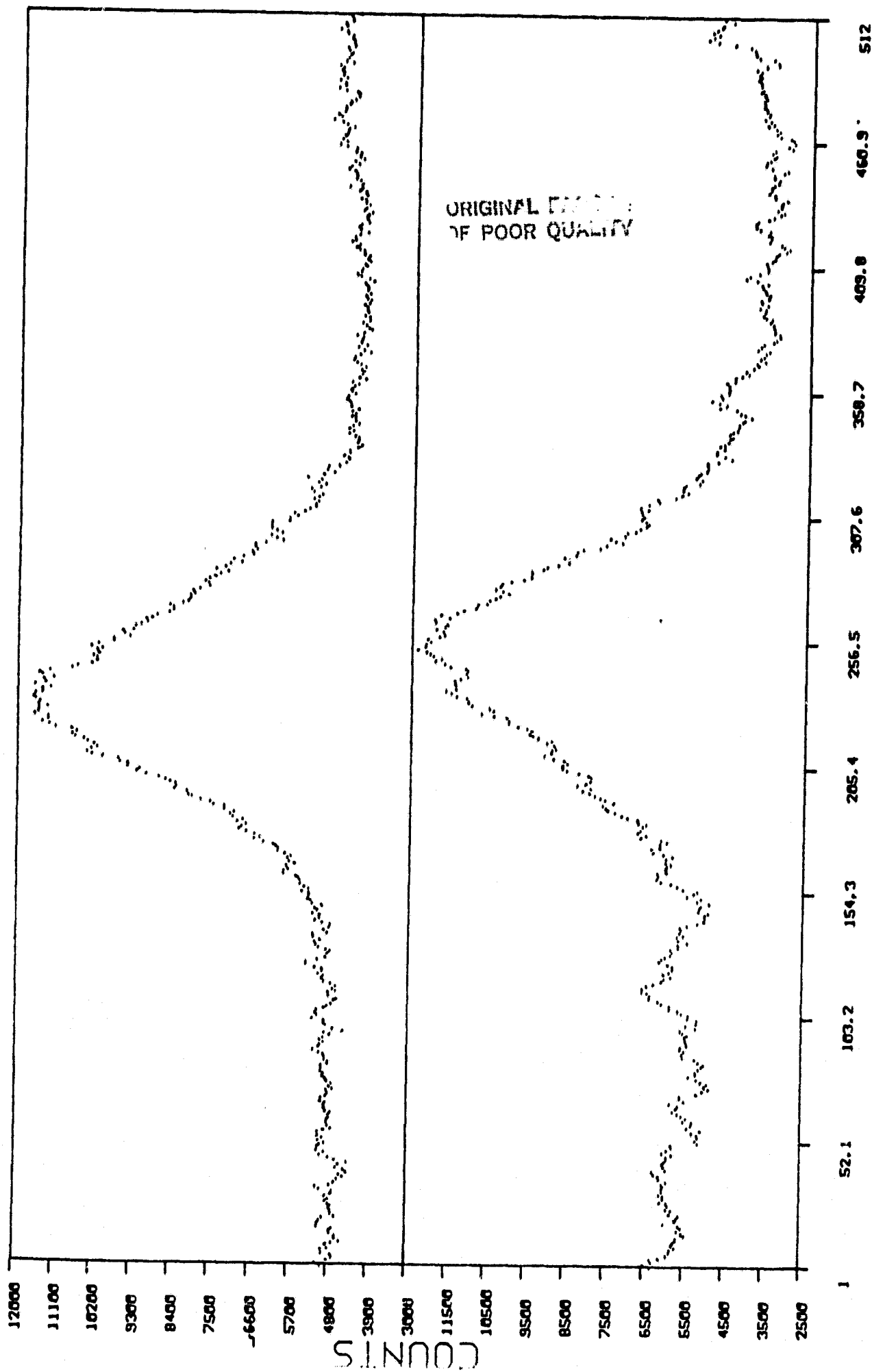
# SILVER FLIGHT/CONTROL - 0 (1s)



channels

Fig 23

# SILVER FLIGHT/CONTROL (SPUTTERED) - 0 1s

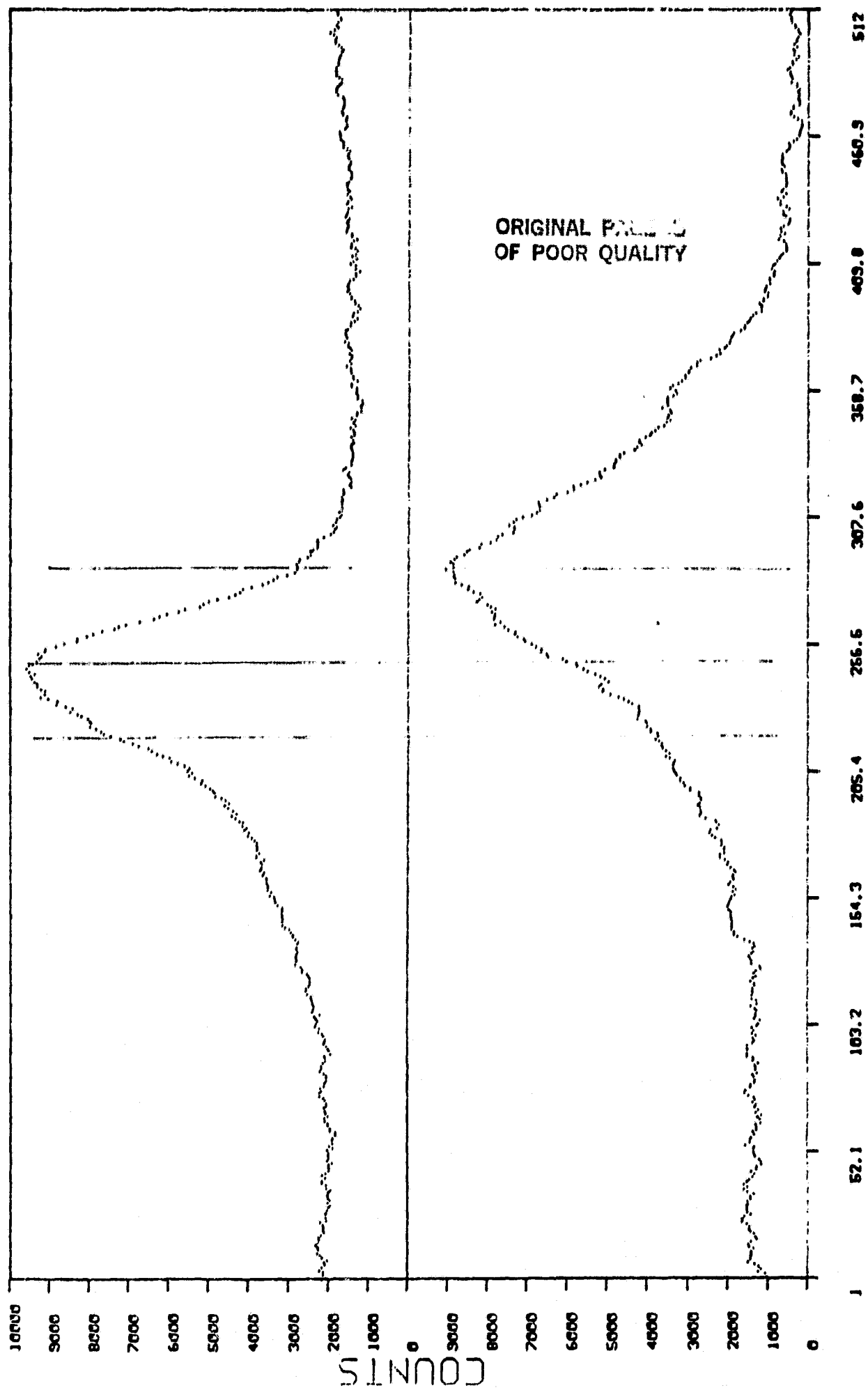


CHANNELS

Fig 24



# SILVER FLIGHT/CONTROL - C (1s) peak



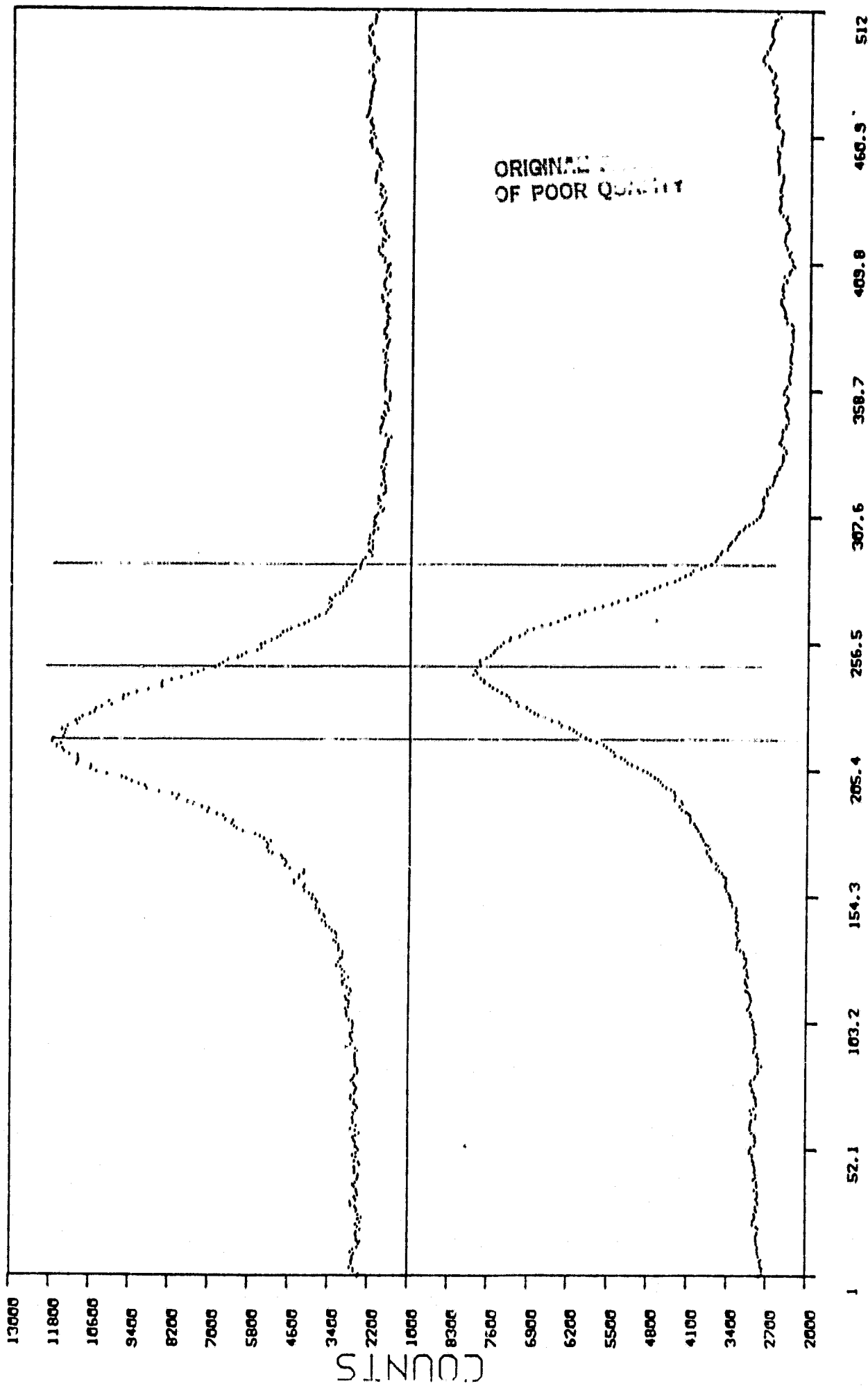
CHANNELS

Fig 2c

59 000 3/5

AG4

# SILVER FLIGHT/CONTROL (SPUTTERED) - C (1s) peak



SO 1803/1 AC1  
SO 2512/1 ACBL12

Sample: Copper / Flight

Treatment:

Date: 7-14-84

scan	peak	B.E. (eV)	ch. #	inten:	$E_0$ (eV)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
CU4	Cu 2p <sub>3/2</sub>			$5 \times 10^4 / 5$	100		1,072,000	$1.072 \times 10^7$	10	8.18		
	Cu 2p <sub>1/2</sub>									15.9		
CU6	O(1s)			$5 \times 10^3 / 1$	50		1,009,000	$7.019 \times 10^7$	14	24.08	0.17	Cu
										2.55		
CU2	C(1s)			$5 \times 10^3 / 1$	100	NSA (x3)			15	1.00	0.19	C
							169,000	$7.535 \times 10^7$			0.64	C

ORIGINAL PARTIAL  
OF POOR QUALITY

Comments:  $Cu \sim 1 \rightarrow CuO$

Figures:

Table 2

Sample: Copper Control  
 Treatment:  
 Date:

scan	peak	B.E. (ev)	ch. #	inten.	E <sub>0</sub> (ev)	height (counts)	area	norm. area	escape depth	cross sect.	mole frac.	
CUBL <sup>2</sup>	Cu 2p <sup>3/2</sup>	953.6		$5 \times 10^{14}/5$	100				10	8.18		
		952.2										
	Cu 2p <sup>3/2</sup>	933.6								15.9		
		932.4										
						total	935,000	$8.35 \times 10^7$		24.08	0.083	Cu
CUBL <sup>3</sup>	C (1s)			$1 \times 10^{17}/1$	100		717,000	$7.17 \times 10^7$	14	2.85		
											0.43	O
CUBL <sup>4</sup>	C (1s)			$5 \times 10^{17}/1$	100				15	1.20		
						total	615,000	$3.075 \times 10^7$			0.49	C

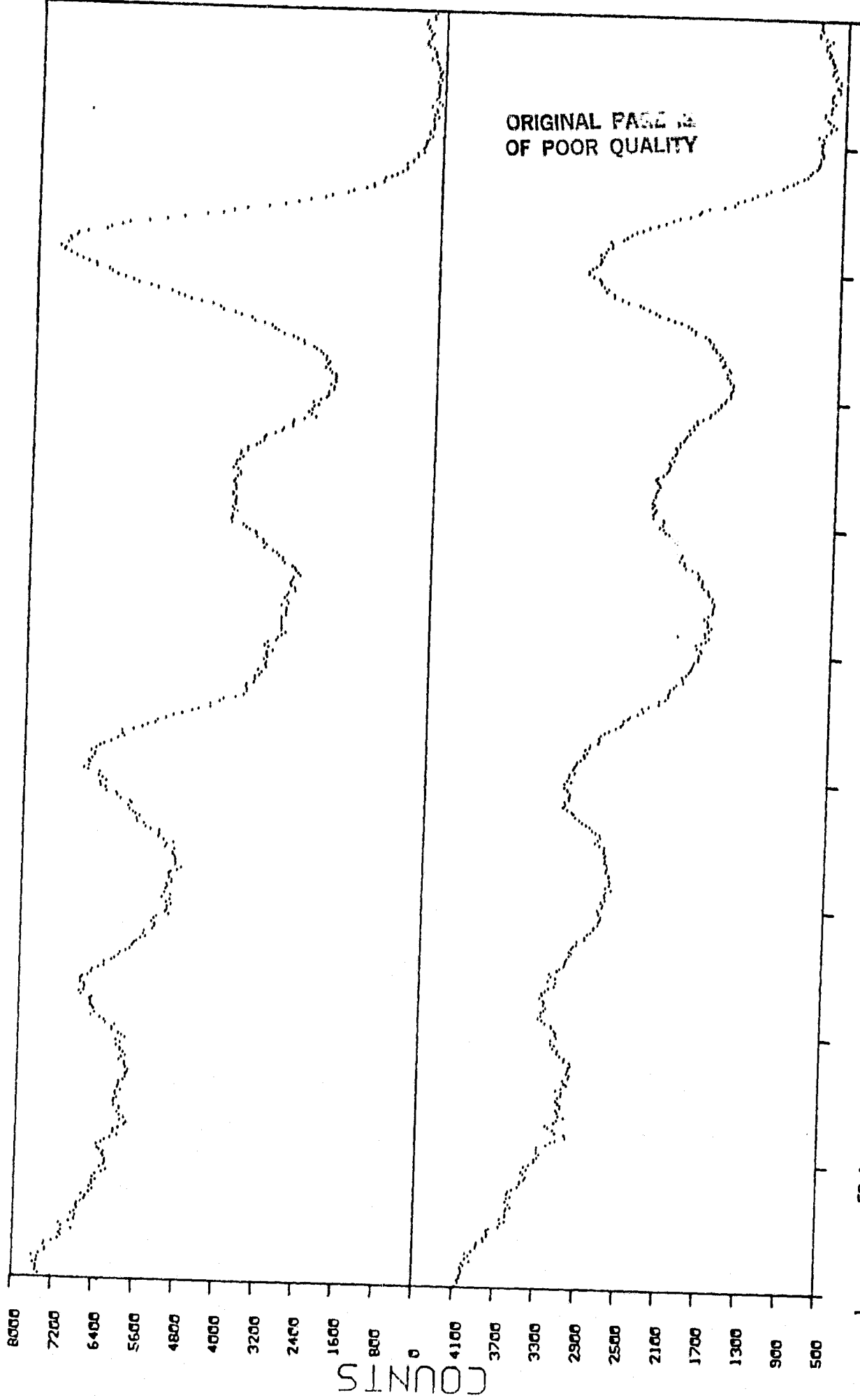
Comments:

Figures:

ORIGINAL PAGE IS  
 OF POOR QUALITY

Table A

# COPPER FLIGHT/CONTROL - Cu 2p 1/2 and 2p 3/2

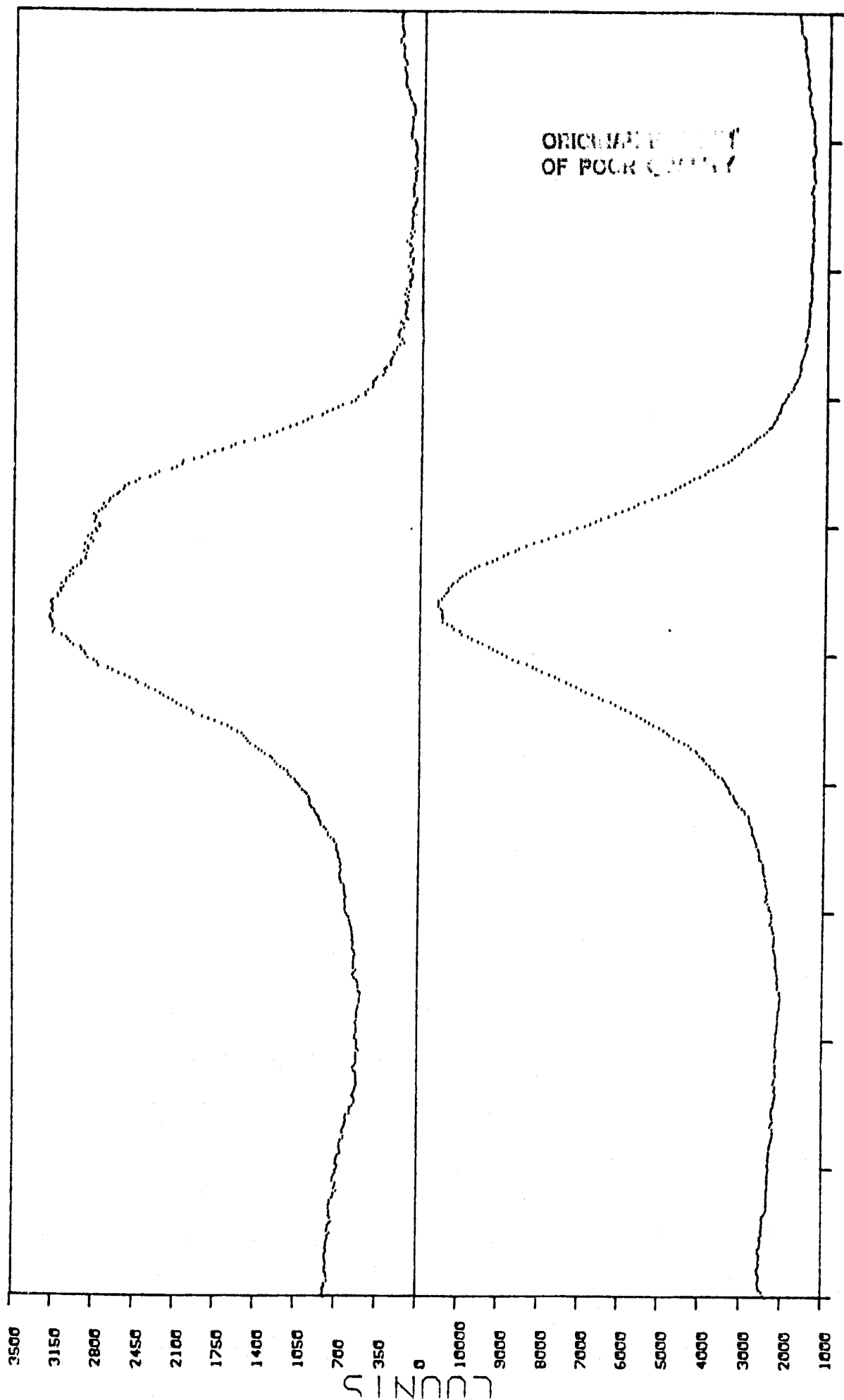


CHANNELS

100 5X10<sup>4</sup>/s  
Cu 2p 1/2

Cu 2p 3/2

# COPPER FLIGHT/CONTROL - 0 1s



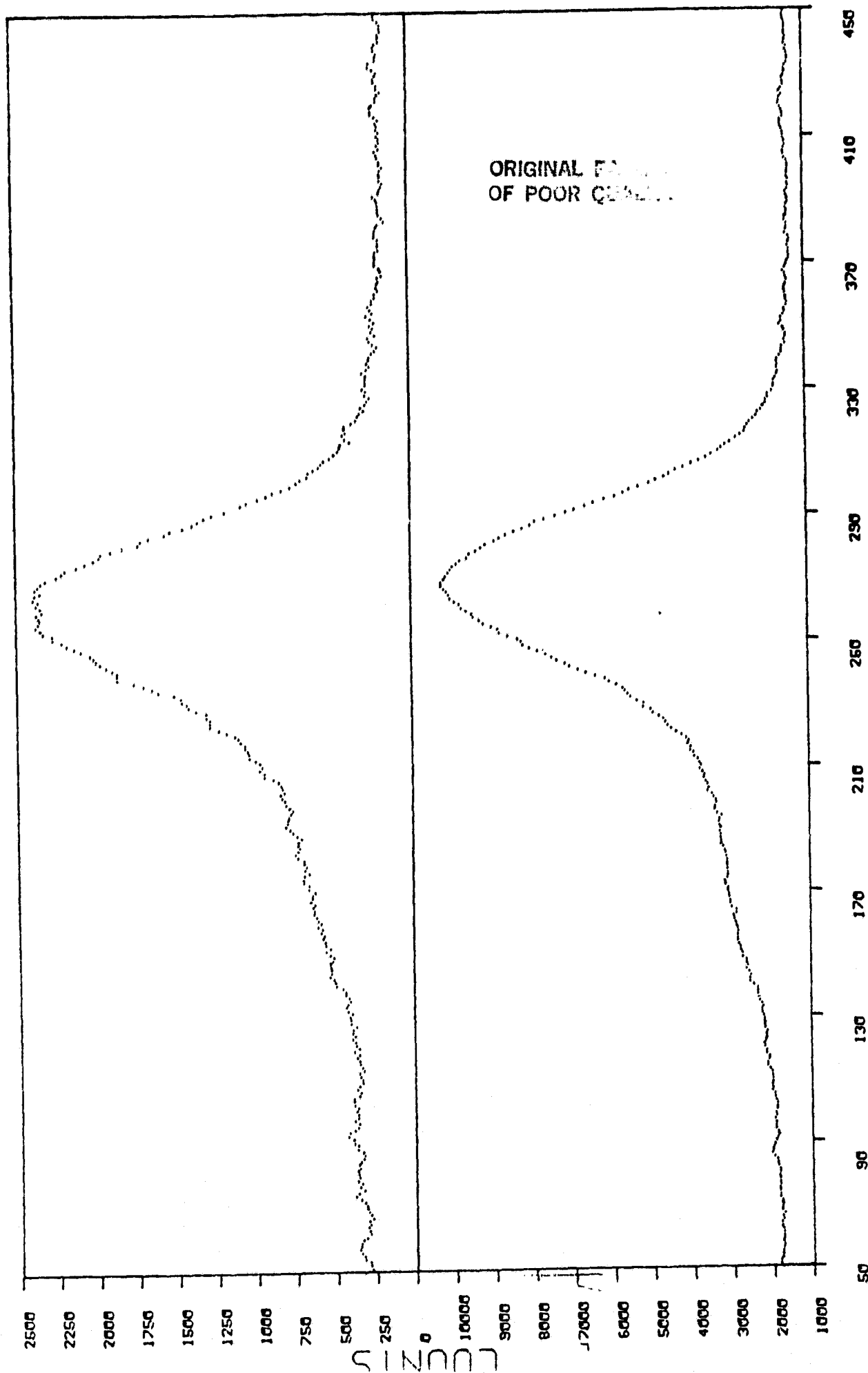
CHANNELS

FIG 28

50 5X10<sup>7</sup>/S  
100 1X10<sup>8</sup>/S

CU3  
CU8L3

# COPPER FLIGHT/CONTROL - C 15



ORIGINAL RECORD  
OF POOR QUALITY

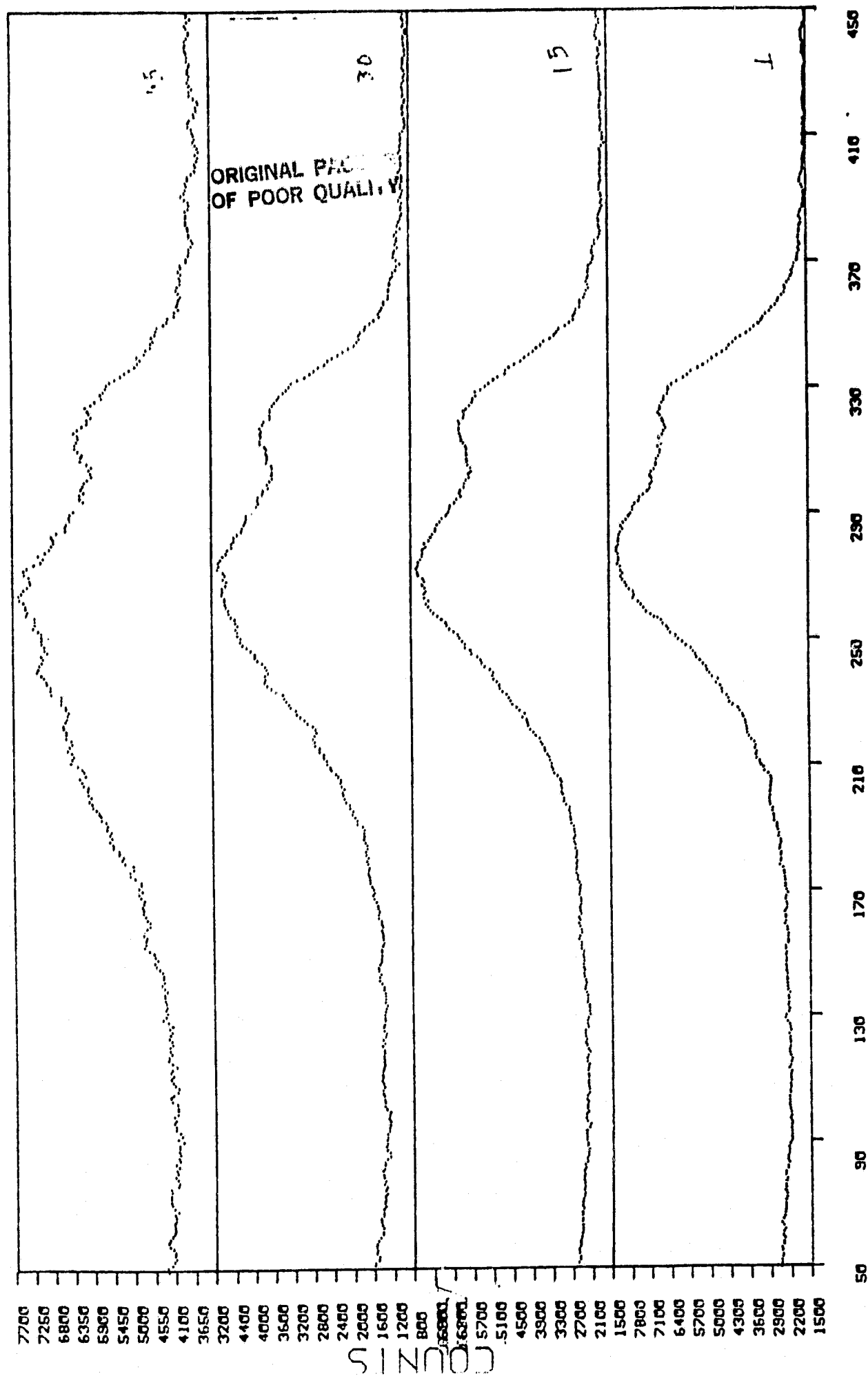
CHANNELS

Fig 29

100 5X10<sup>3</sup>/1  
100 5X10<sup>3</sup>/1

C02  
C00L4

# Cu FLIGHT SAMPLE - Angle Resolved O 1s Peaks





Sample: A-276 Flight

[illegible]

**Comments:**

## Figures:

ORIGINAL PAGE IS  
OF POOR QUALITY

11

Sample: A-276 Control  
Treatment:  
Date: 8-8-84

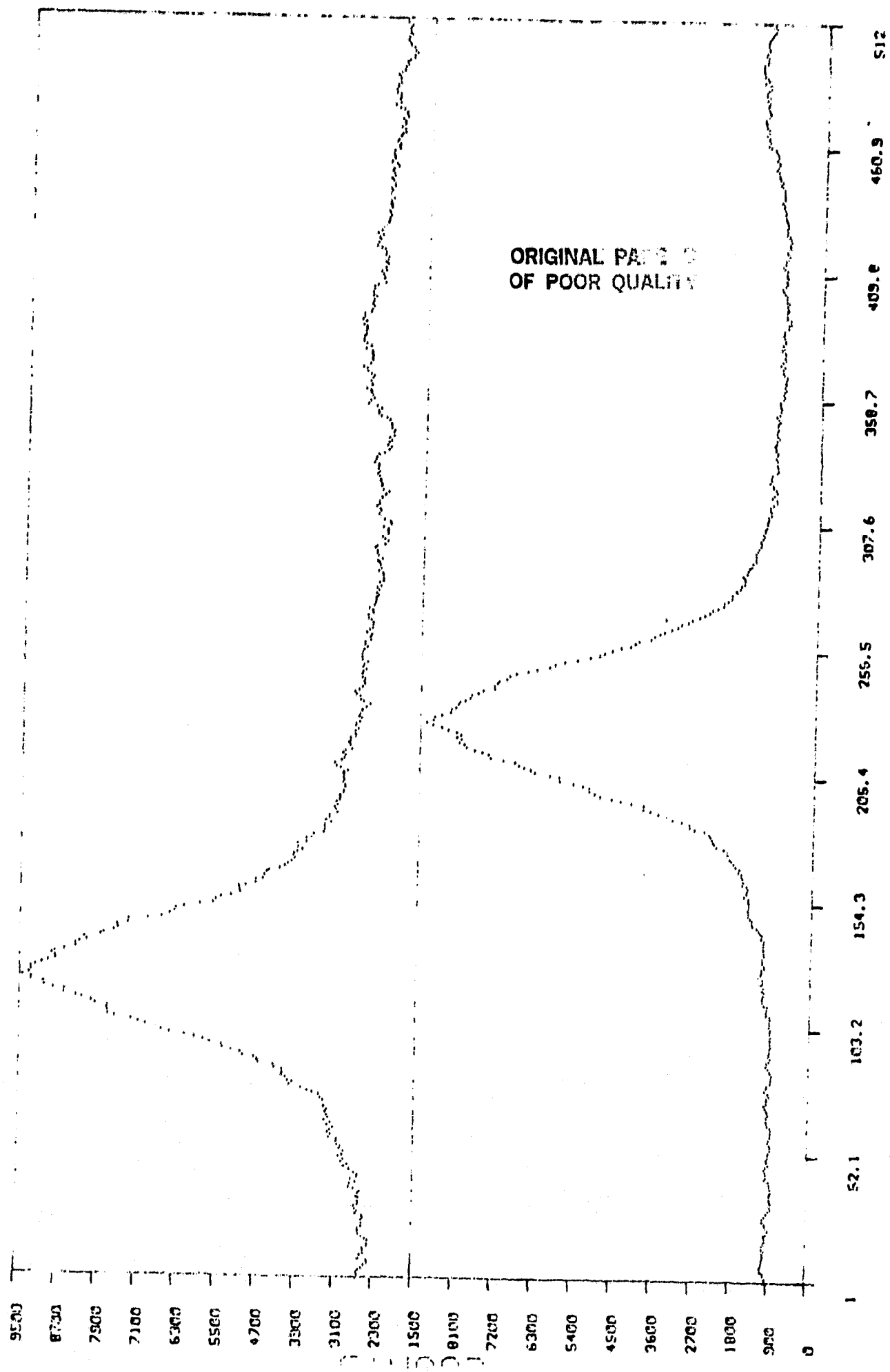
[illegible]

ORIGINAL  
OF POOR QUALITY

**Comments:**

## Figures:

12

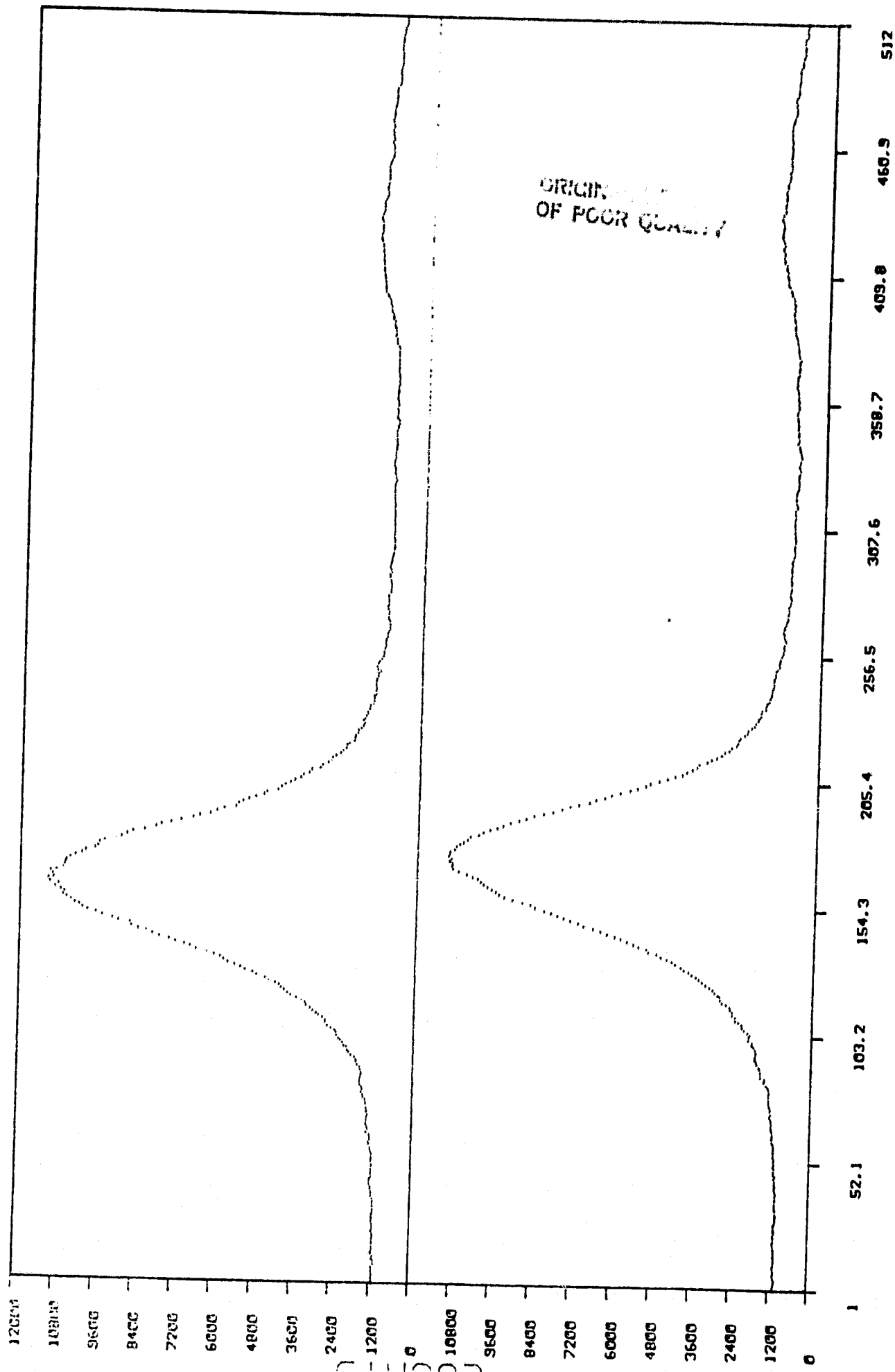


ORIGINAL PAGE IS  
OF POOR QUALITY

CHANNELS

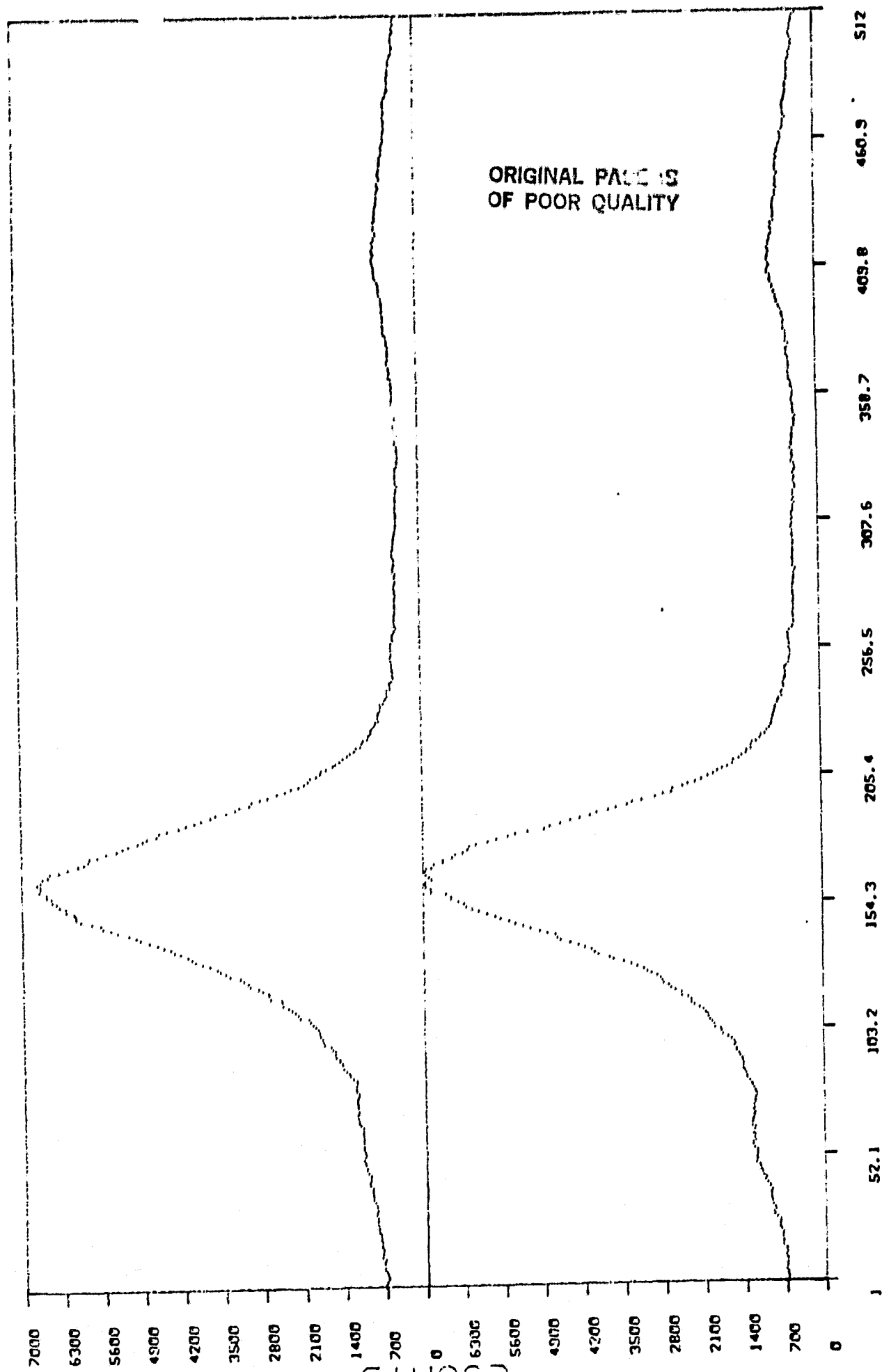
Fig 31

# A276 FLIGHT/CONTROL - 0 1s



CHANNELS

# A276 FLIGHT/CONTROL - C 1s



CHANNELS

Fig. 33

Sample: 2-30-2 15/11/1971

**Treatment:**

**Date:**

[illegible]

**Comments:**

### Figures:

ORIGINAL  
OF POOR QUALITY

2-202

**Treatment:**

**Date:**

[illegible]

**Comments:**

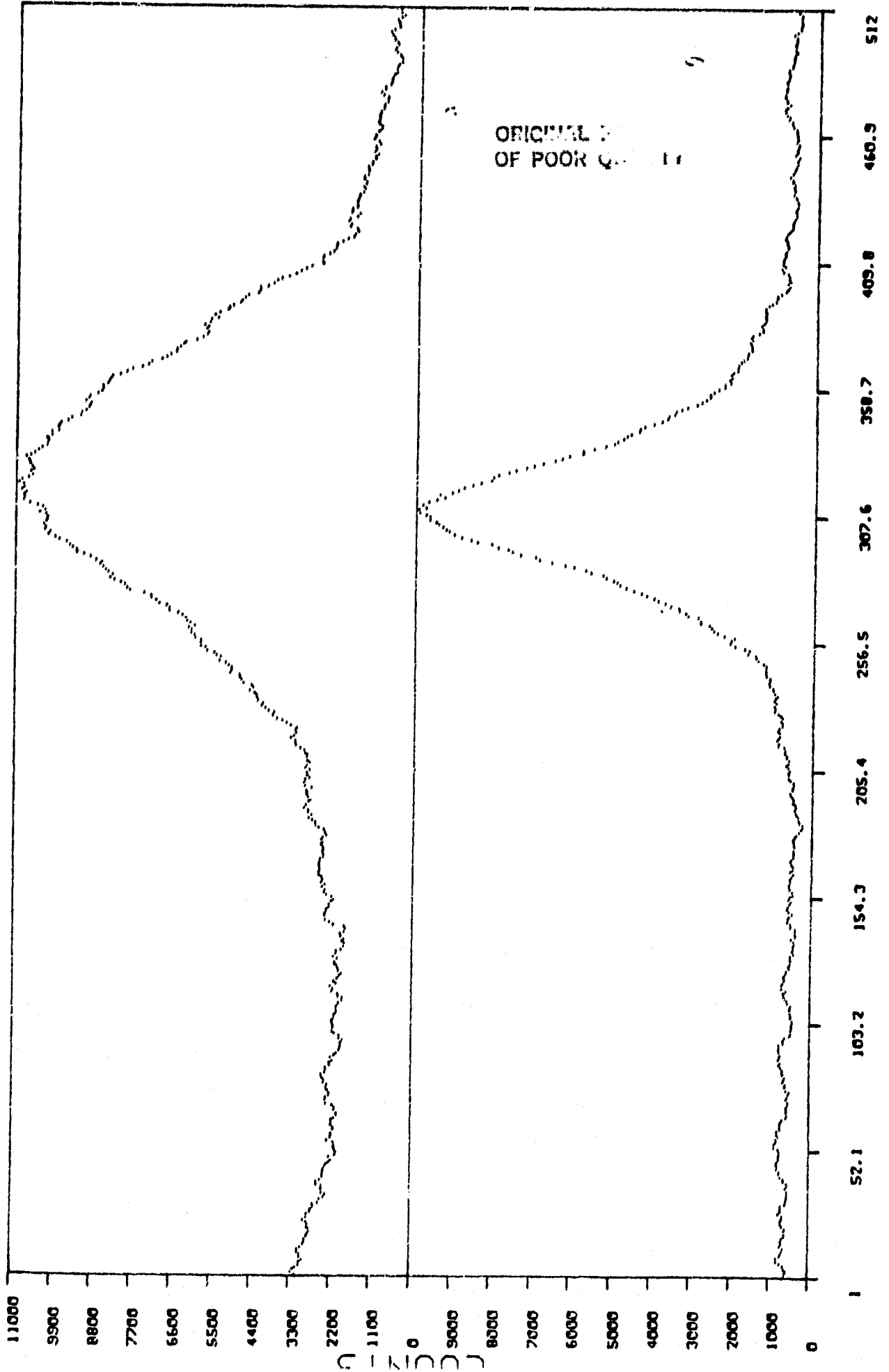
50

### Figures:

ORIGINAL FROM  
OF POOR QUALITY

Table 14

# Z-302 FLIGHT/CONTROL - Si 2p

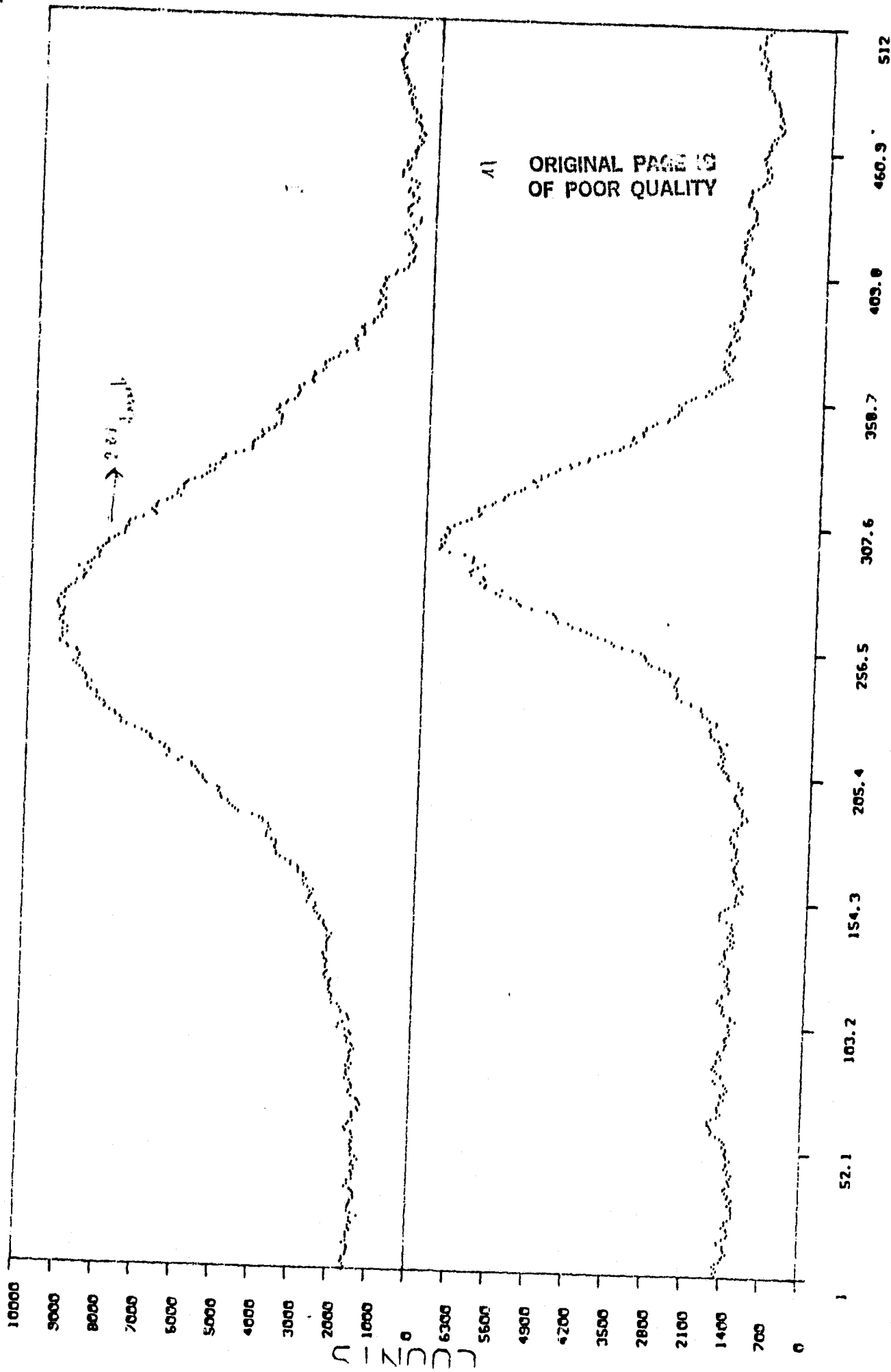


CHANNELS

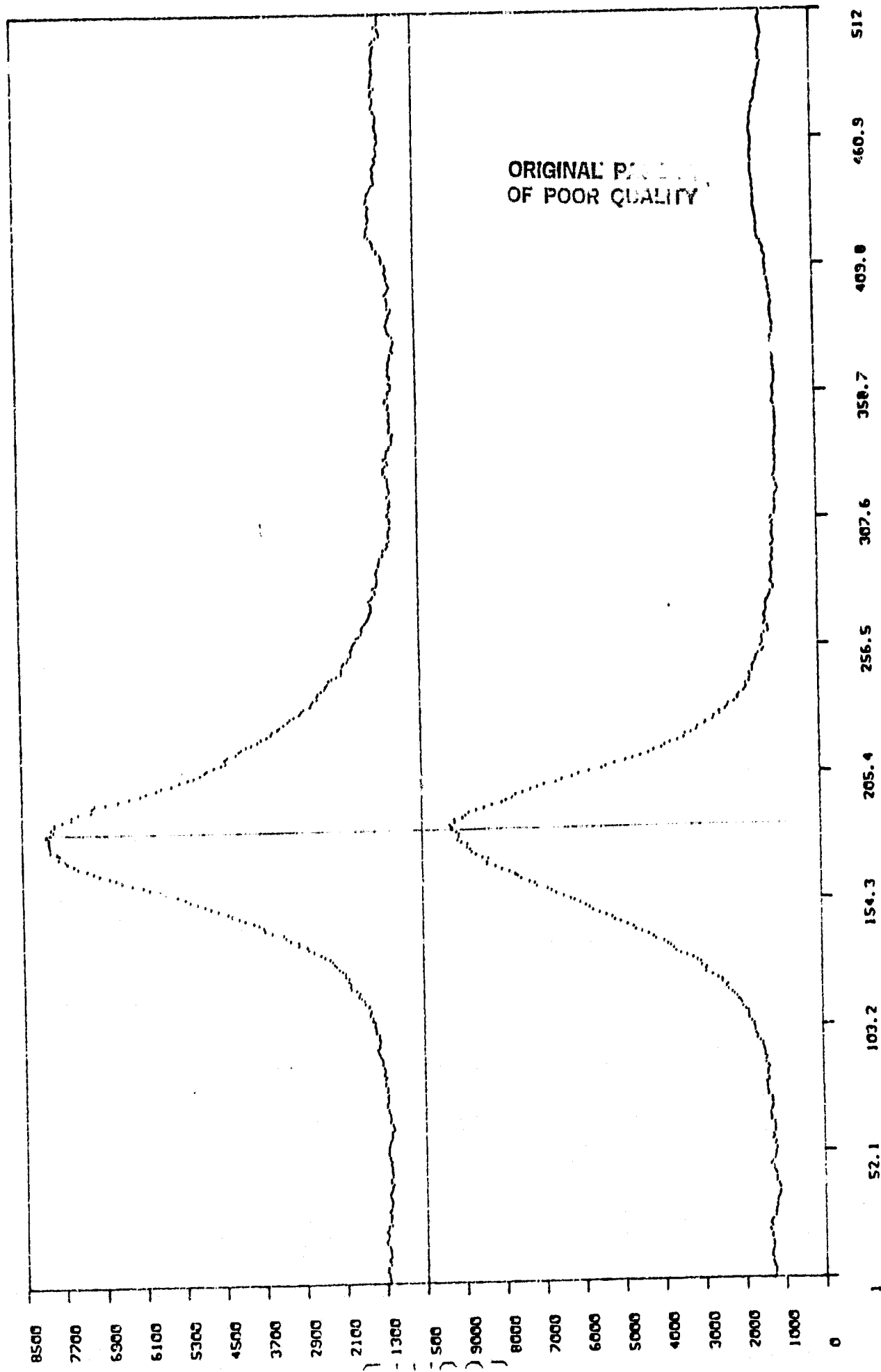
FIG 34



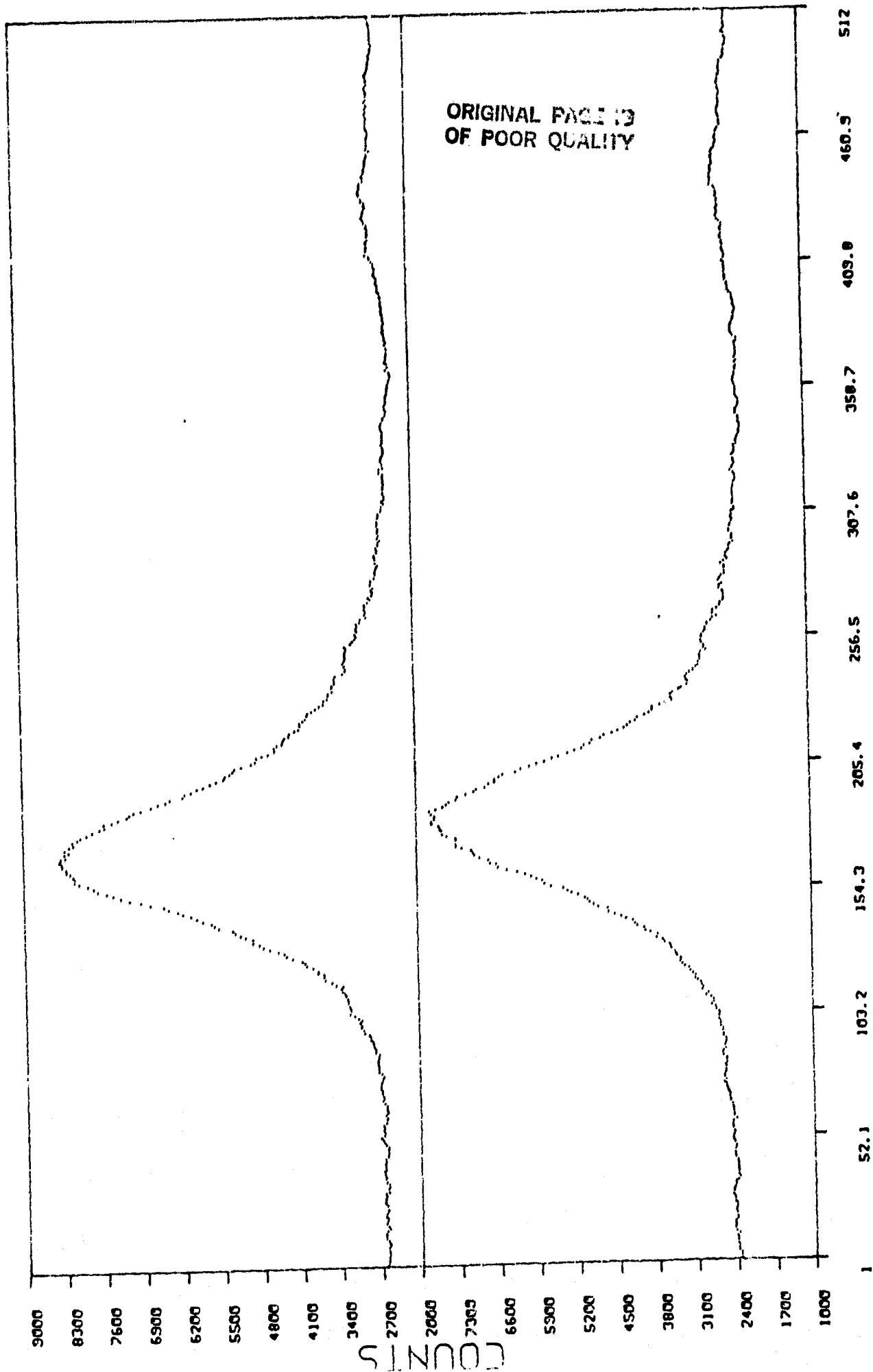
# Z-302 FLIGHT/CONTROL (SPUTTERED) - Si 2p



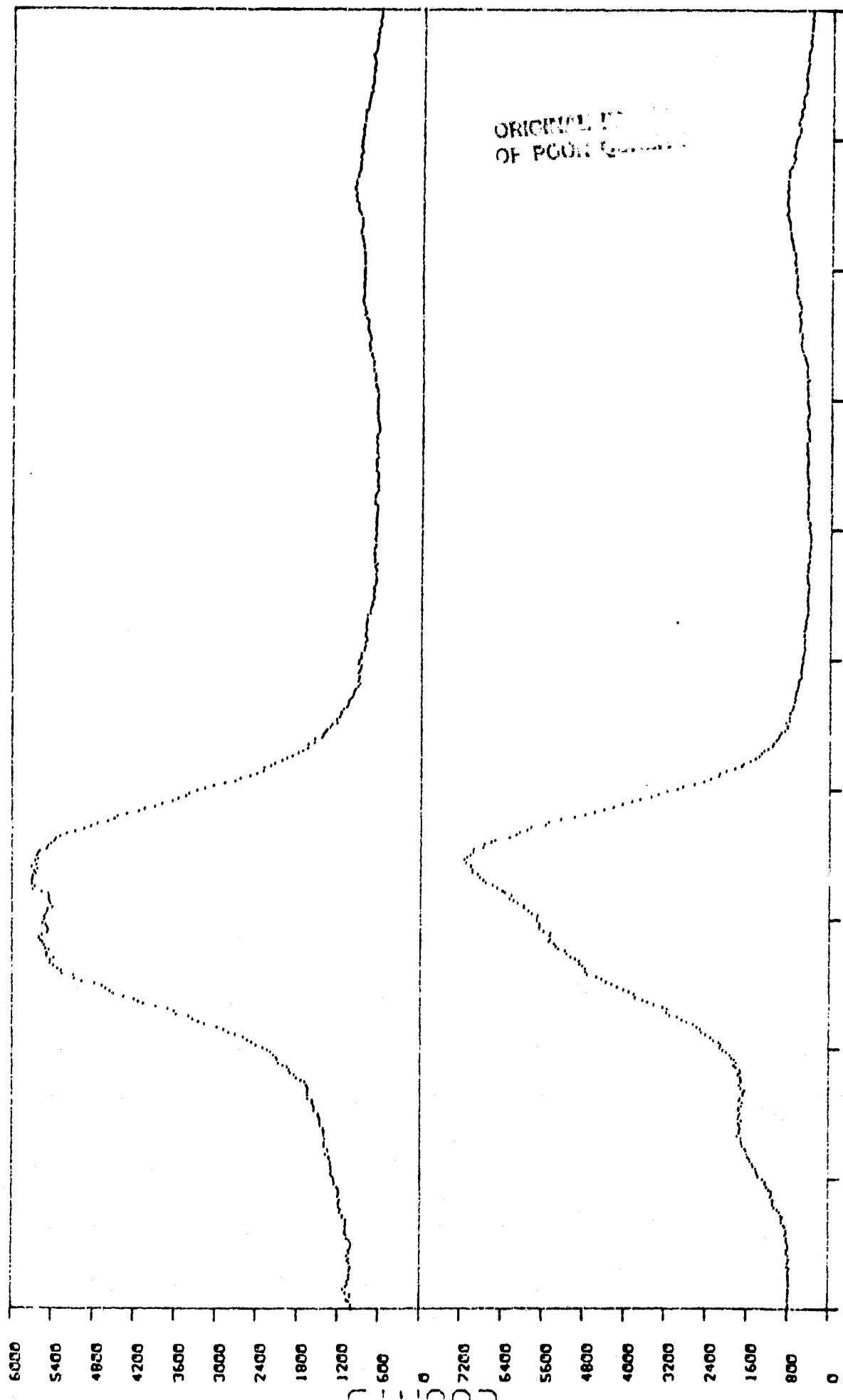
# 2-302 FLIGHT/CONTROL - 0 1s



Z-302 FLIGHT/CONTROL (SPUTTERED) - 0 1s



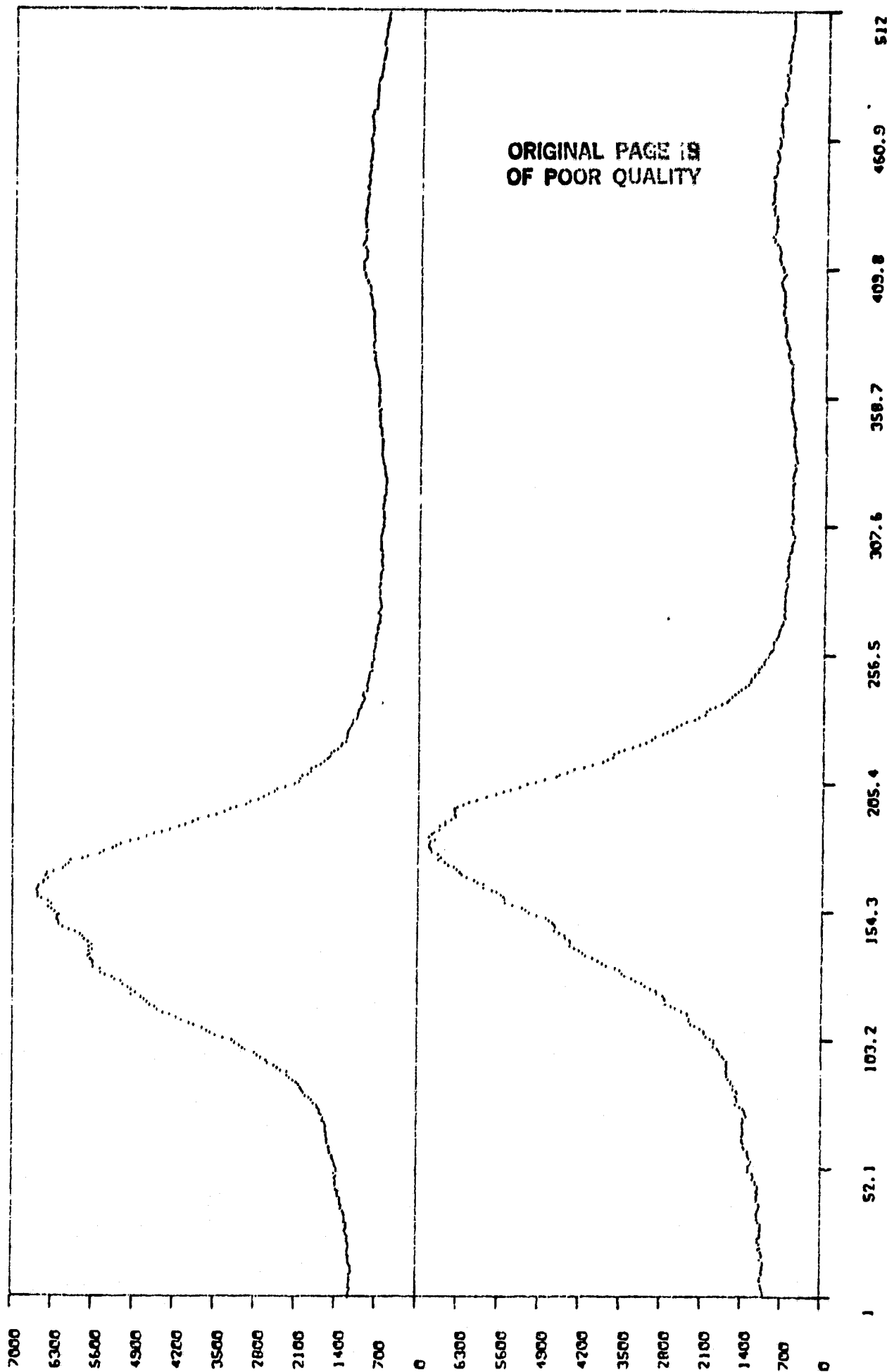
# Z-302 FLIGHT/CONTROL - C 15



CHANNELS

P. 15

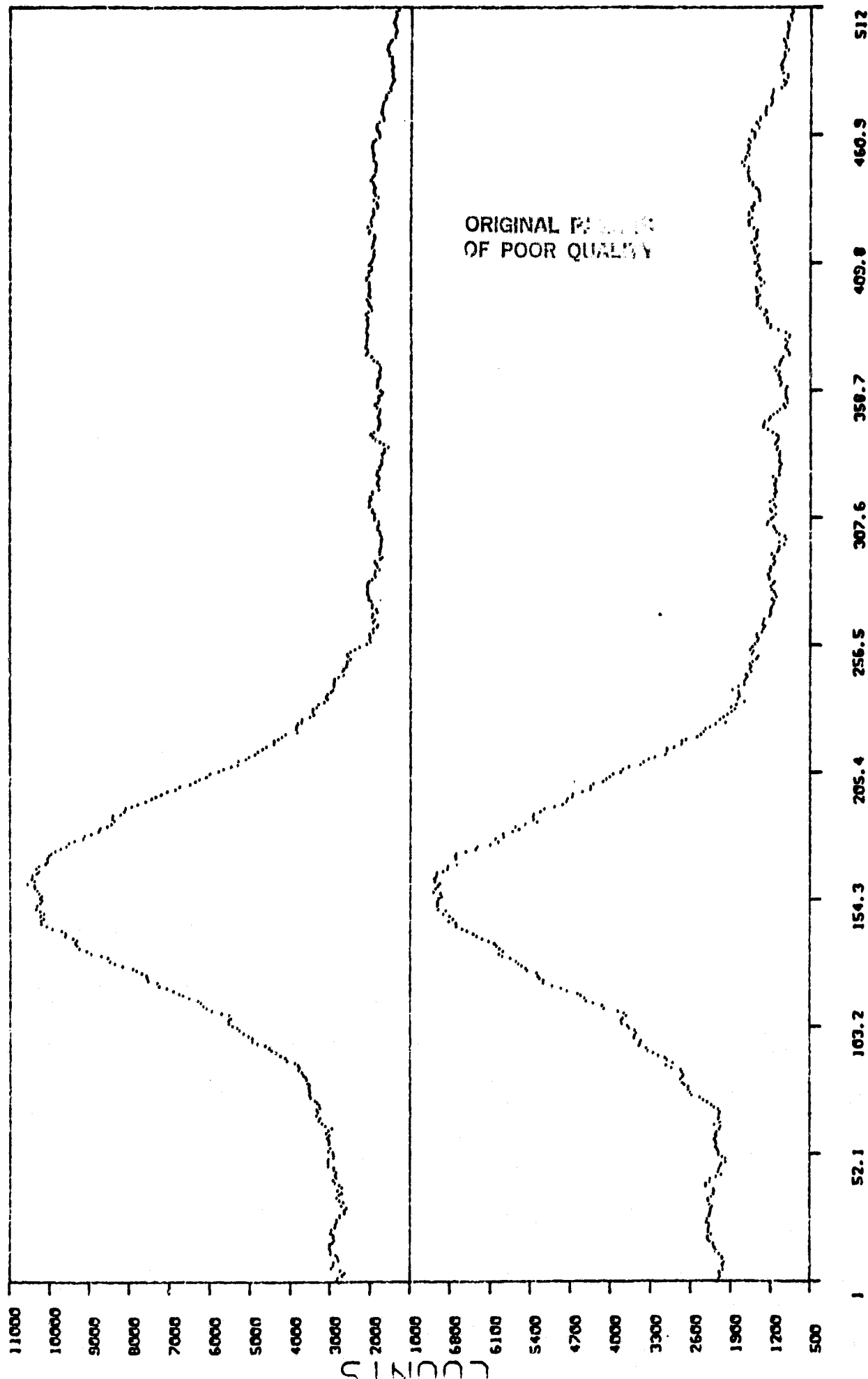
# Z-302 FLIGHT/CONTROL (SPUTTERED) - C 1s



CHANNELS

Fig 39

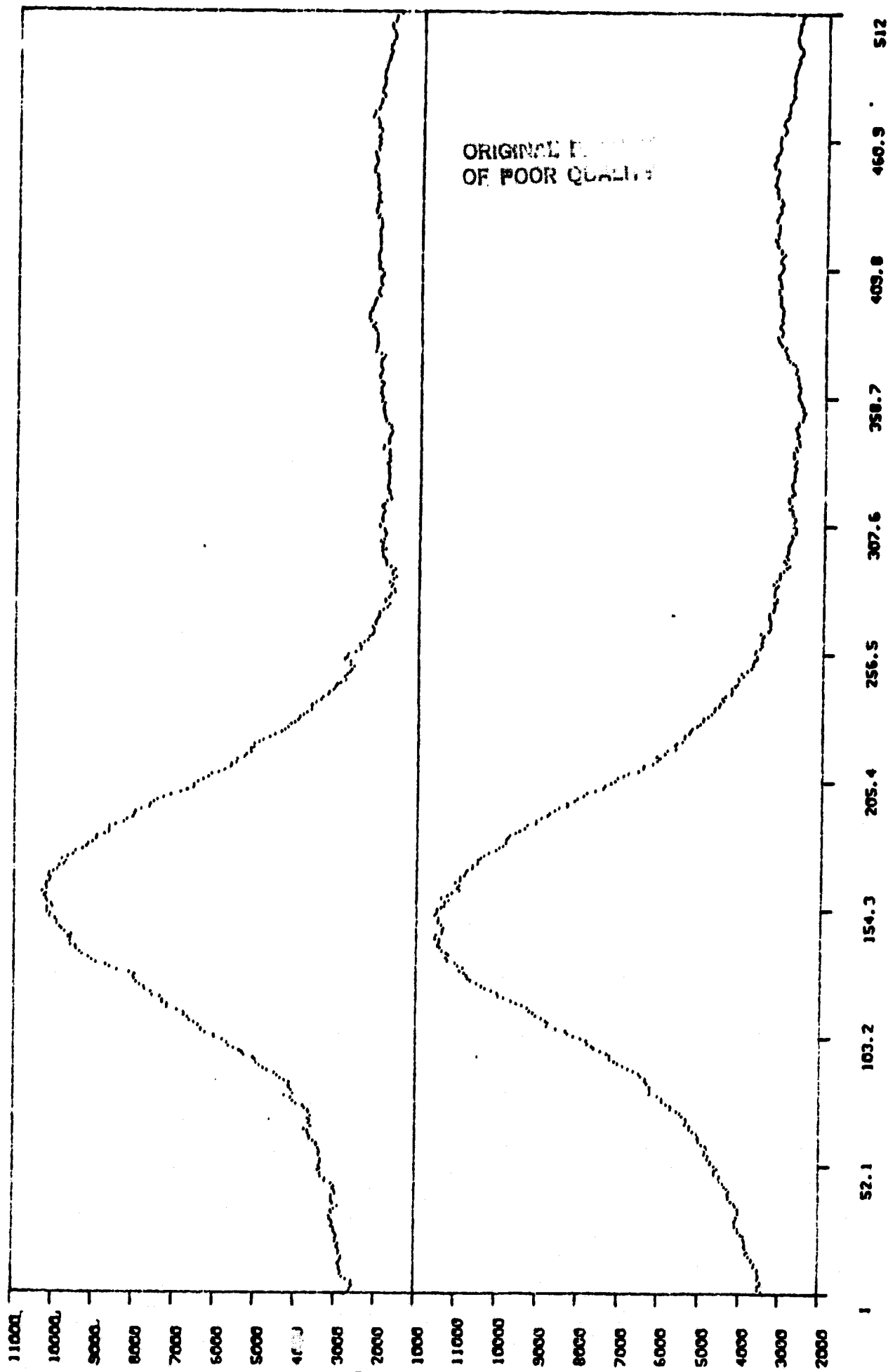
# Z-302 FLIGHT/CONTROL - N 1s



CHANNELS

Fig 40

# Z-302 FLIGHT/CONTROL (SPUTTERED) - N 1s



CHANNELS

Fig 41

02-154

**Treatment:**

**Date:**

**DECS**

low is level

St. John's College

## Figures:

ORIGINAL  
OF POOR Q

## Table 15



Sample: 401-107 4-1-77

### Treatment:

**Date:**

[illegible]

**Comments:**

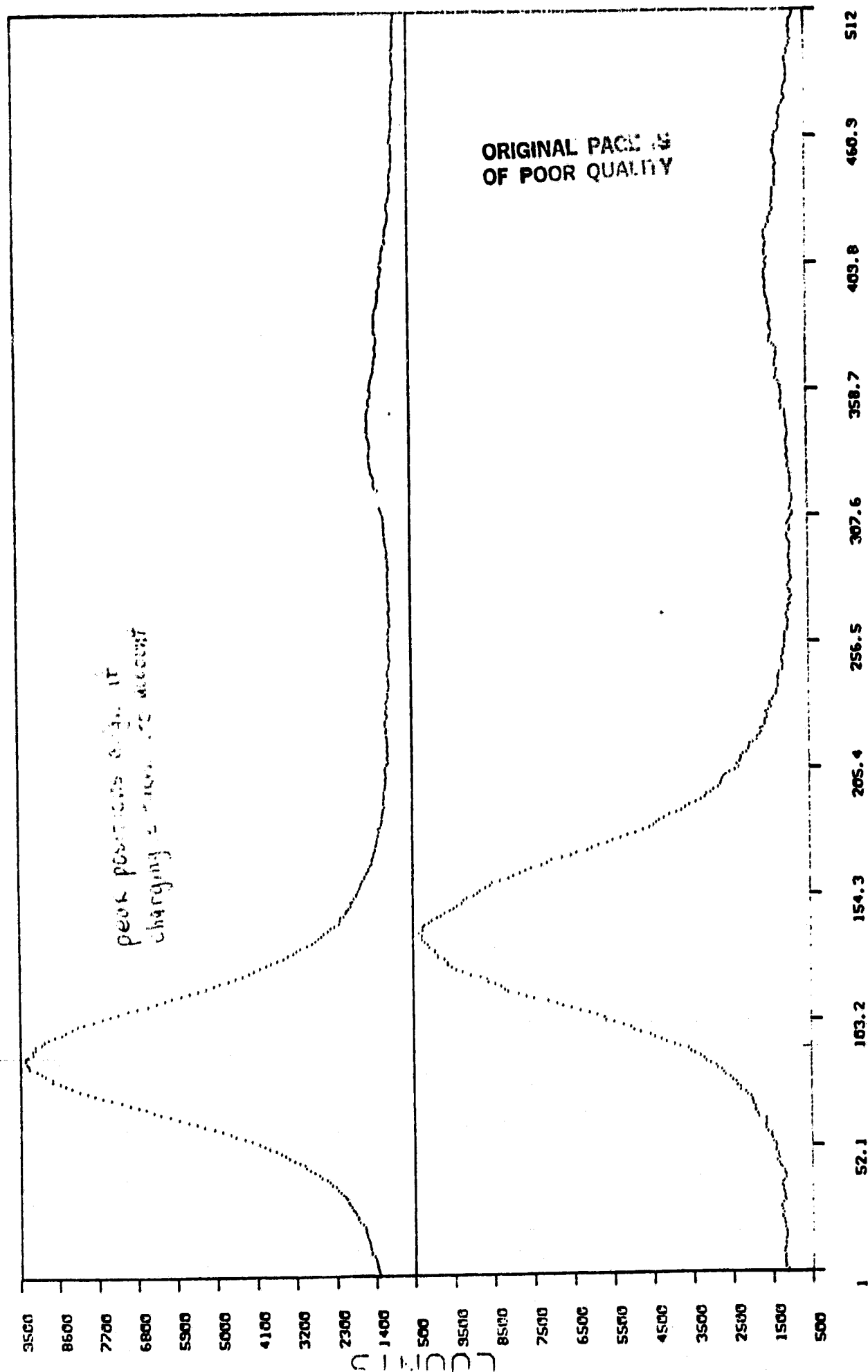
12-15-19

## Figures:

ORIGINAL FACTS  
OF POOR QUALITY

Table 16

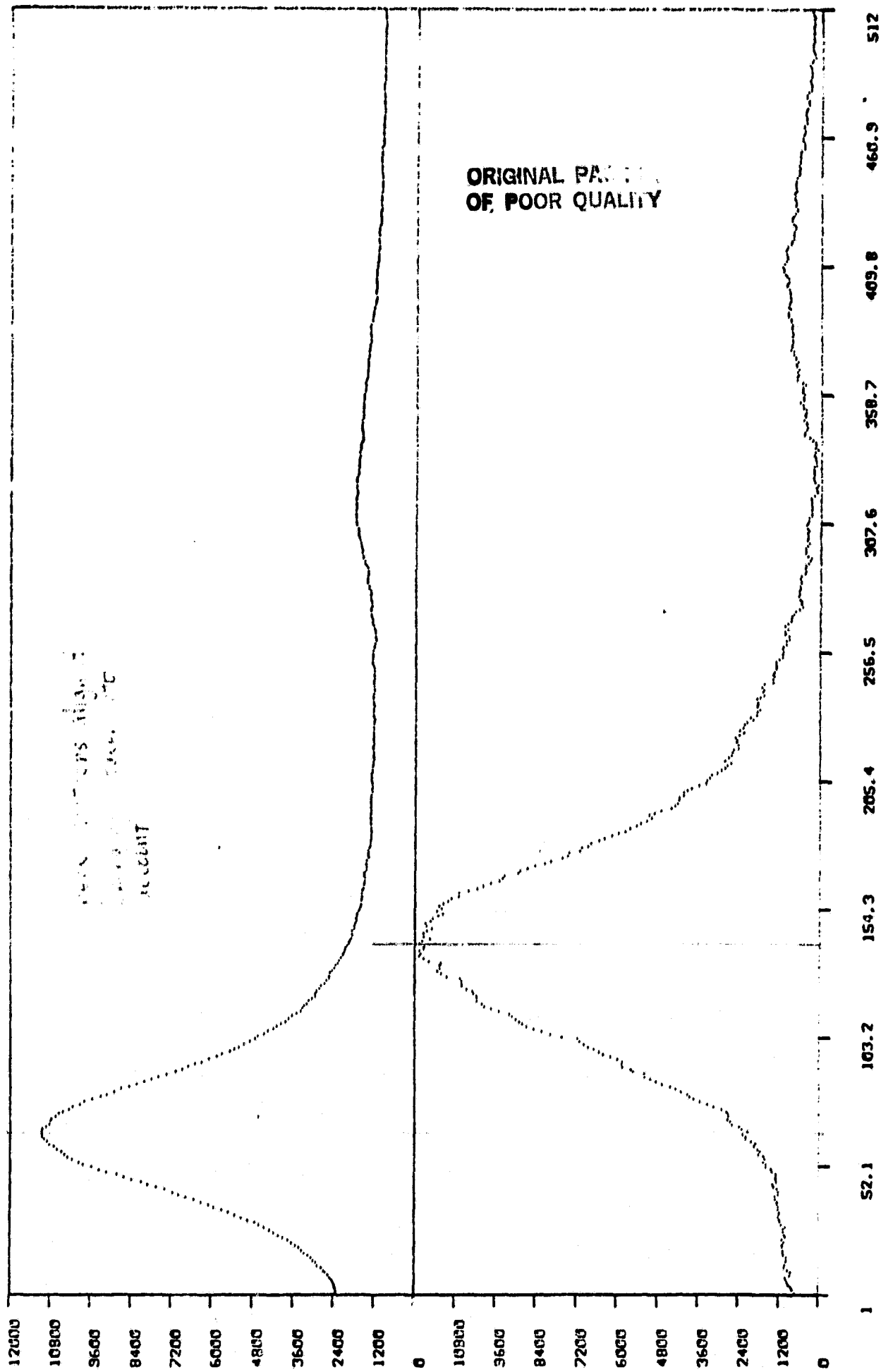
# 401-C10 FLIGHT/CONTROL - 0 1s



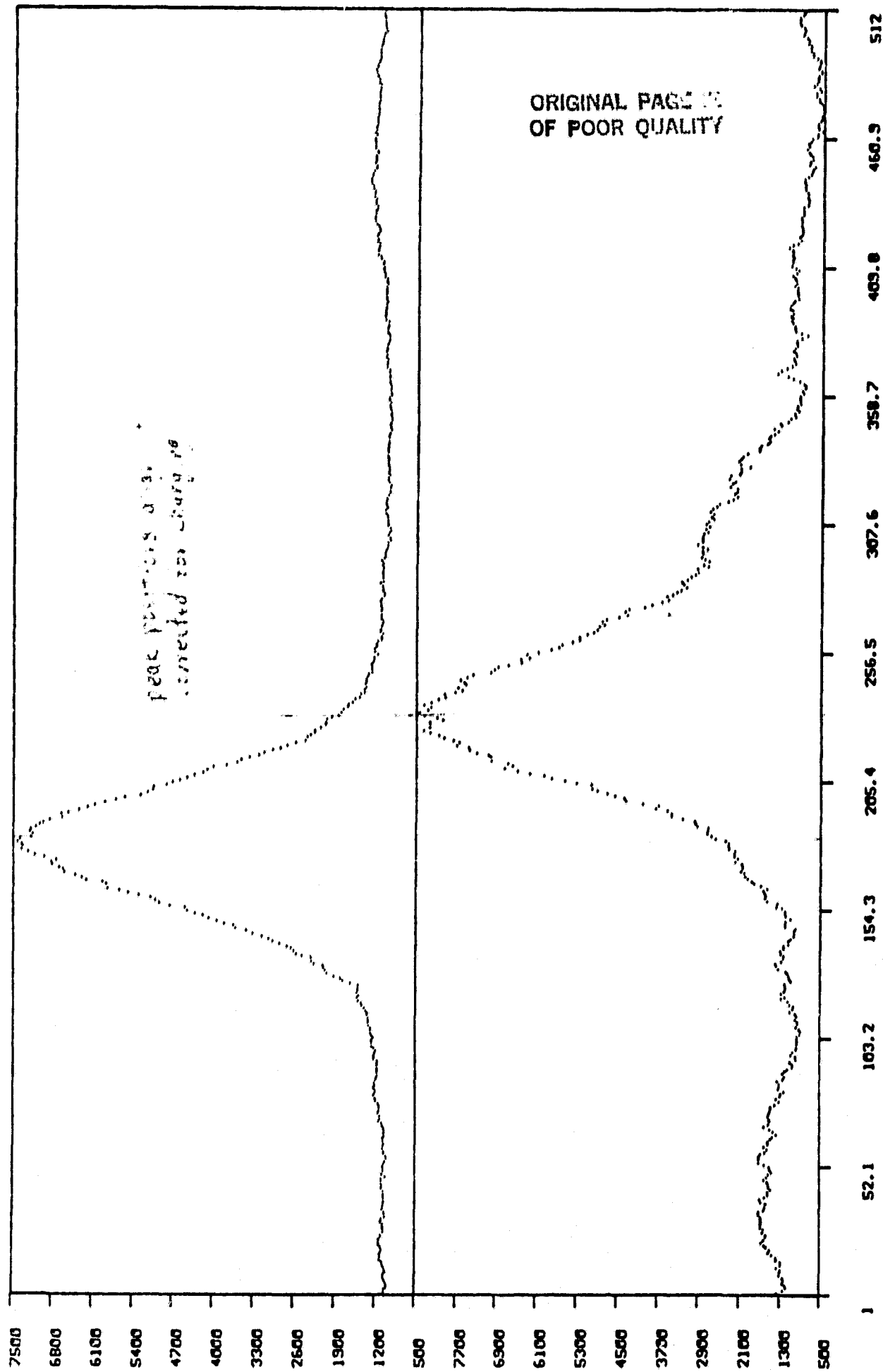
CHANNELS

Fig 42

# 401-C10 FLIGHT/CONTROL (SPUTTERED) - 0 1s



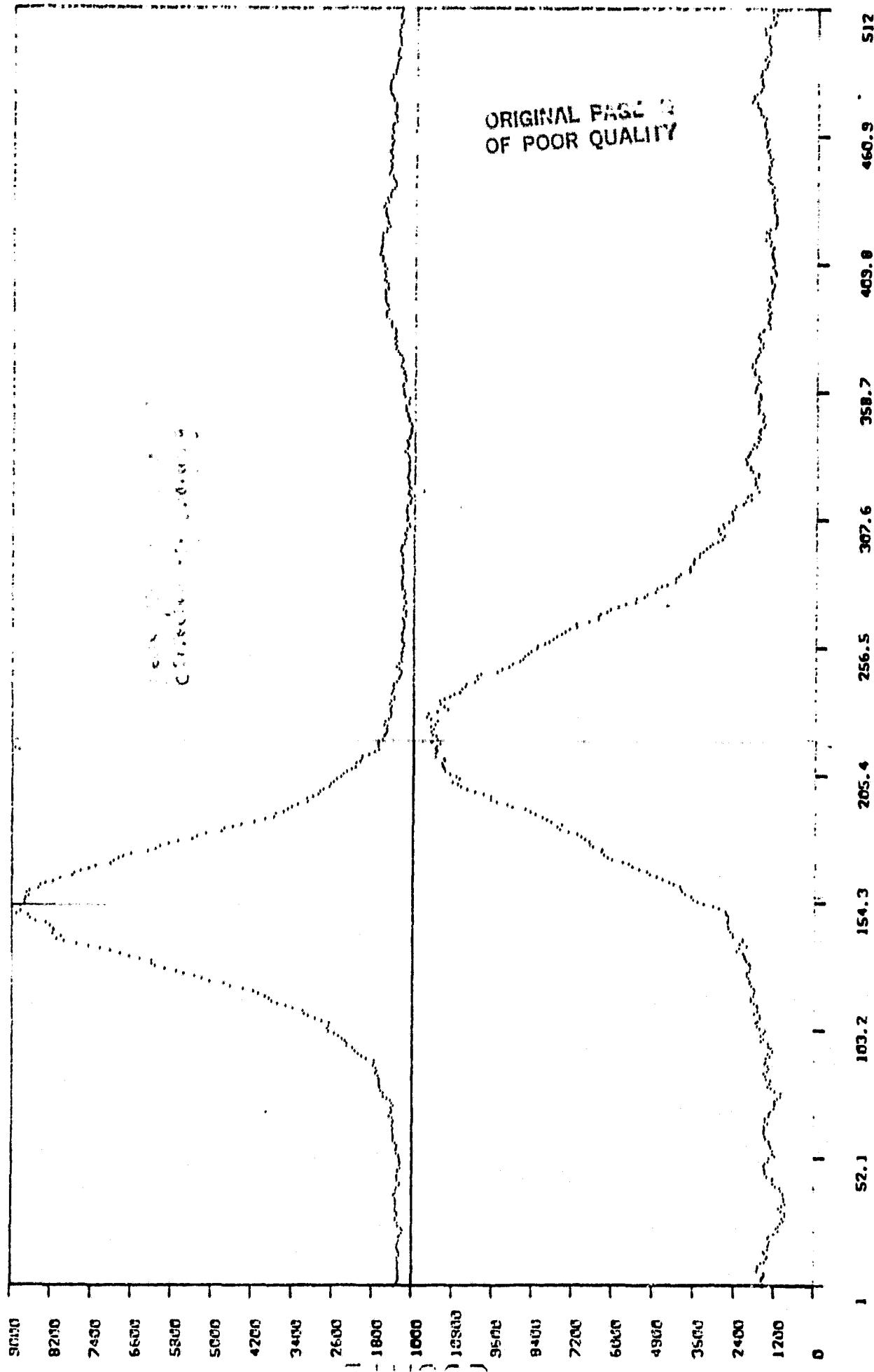
# 410-C10 FLIGHT/CONTROL - Si 2p



CHANNELS

Fig 44

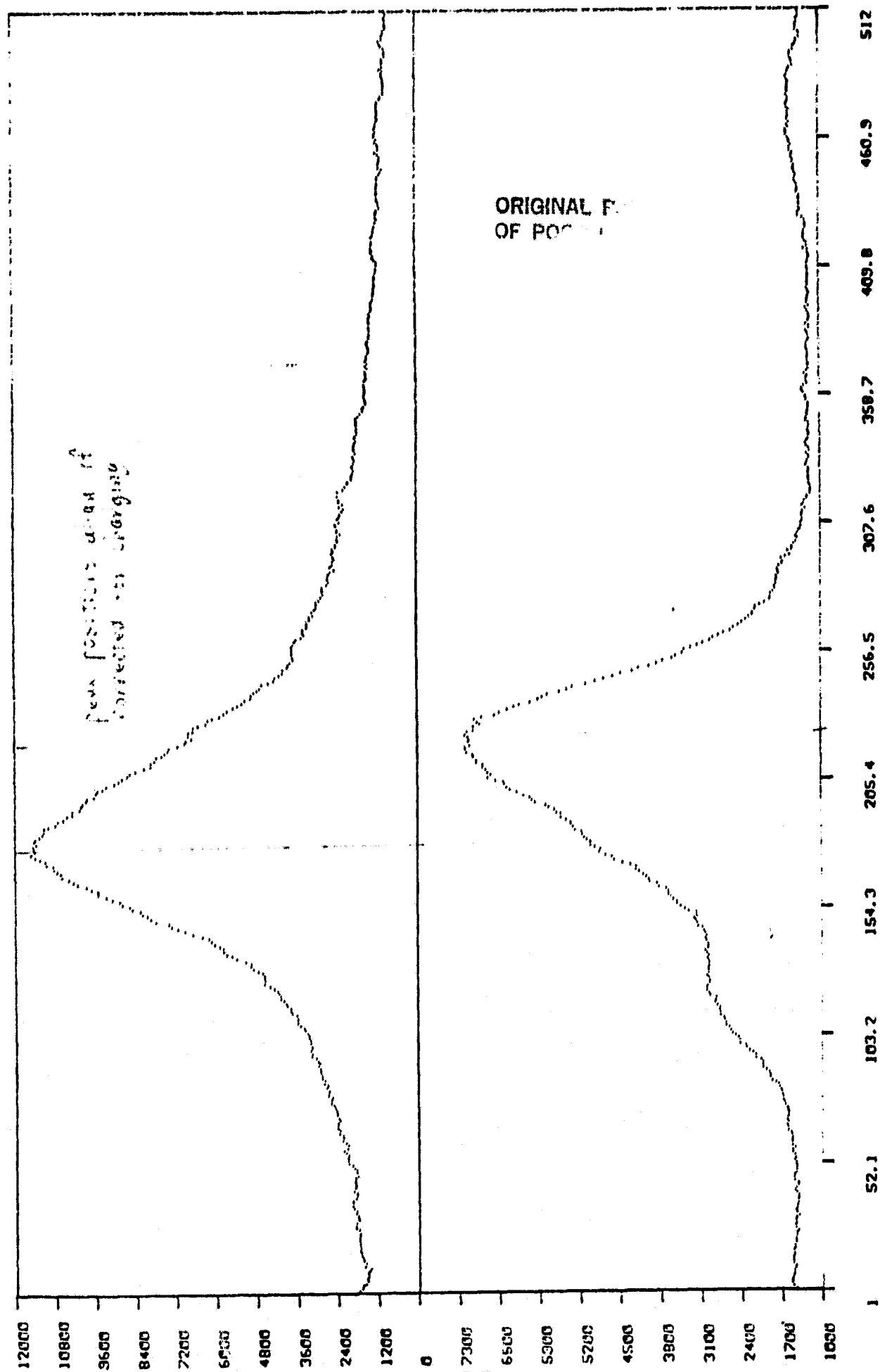
# 401-C10 FLIGHT/CONTROL (SPUTTERED) - Si 2p



CHANNELS

Fig 45

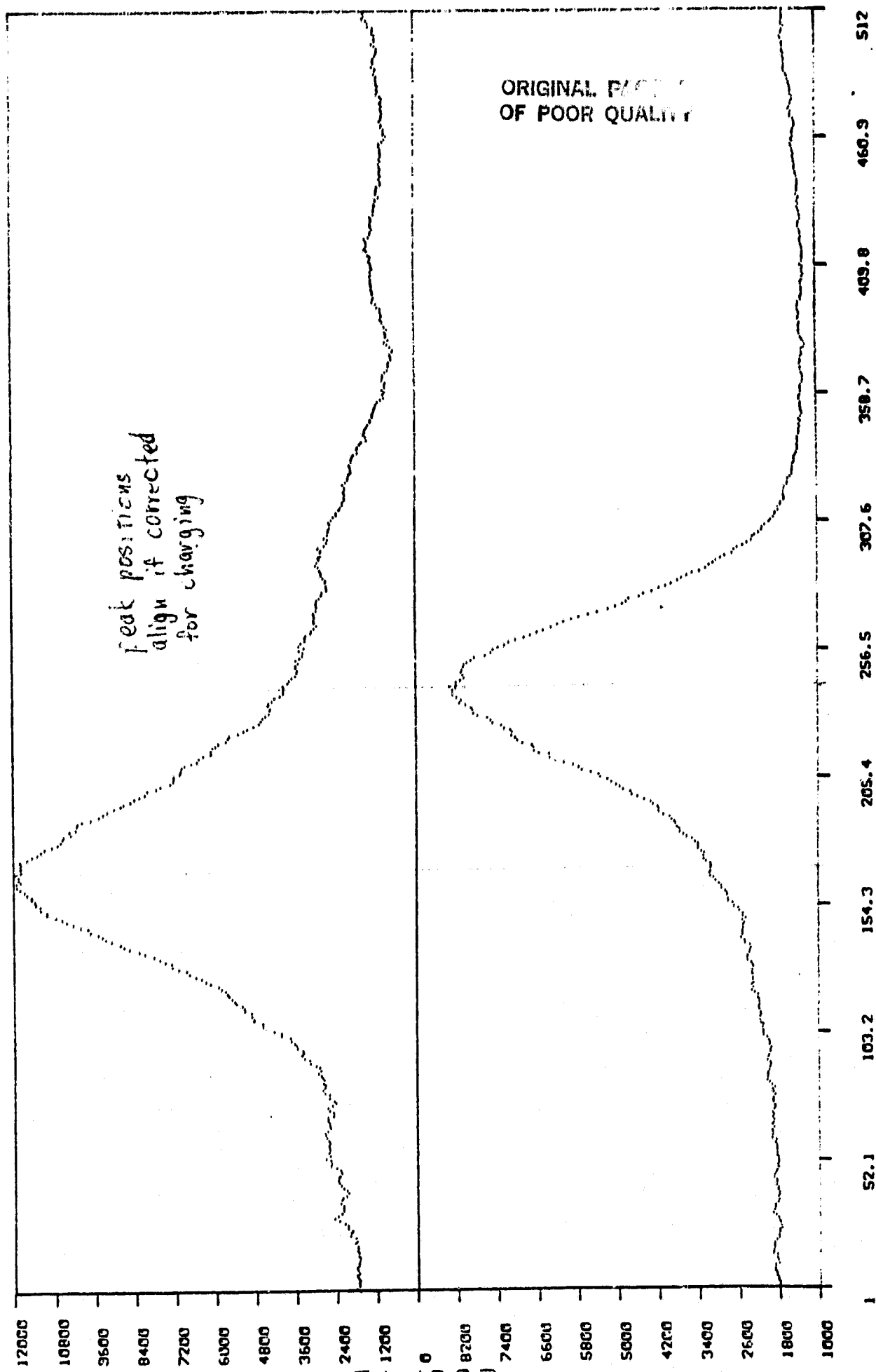
# 410-C10 FLIGHT/CONTROL - C 1s



CHANNELS

Fig 46

# 401-C10 FLIGHT/CONTROL (SPUTTERED) - C 1s



CHANNELS

Fig 47